



Automotive Microcontrollers based on ARM[®] Cortex[®]-M Cores

EUF-ACC-T1574

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Automotive MCUs

Our Direction

Industry & Customer Trends

- A **cleaner** world of low emissions and electrified vehicles
- **Autonomously** driven vehicles with advanced active safety
- The **connected** car, part of the global IoT while remaining safe & secure
- **Mobility** for all, growth in emerging nations, with fast to market advanced solutions

How We Will Meet These Needs

- Powertrain control solutions with integrated motor control and advanced signal processing for the latest hybrid and electric vehicle systems
- Market-leading **SafeAssure** architecture developments for radar, camera and data fusion applications
- Introducing the most advanced **vehicle networking processors** with safety and security architectures integrating the latest encryption and secure vehicle networking protocols
- New hyper-integration **mixed-signal MCUs** for fast time to market. Local applications and solutions labs and low-cost tools to get the new world moving



Powertrain & Hybrid



Advanced Safety

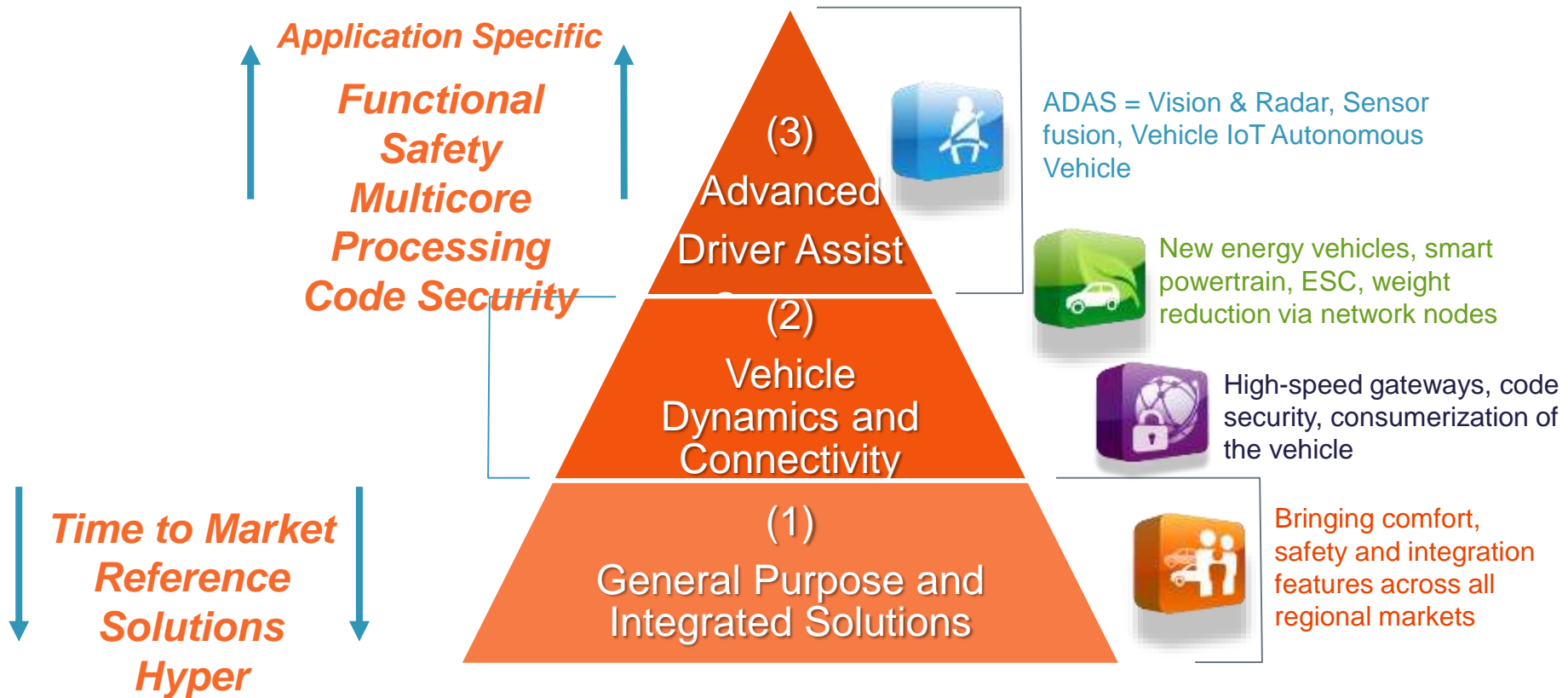


Vehicle Networking



Mobility for All

Automotive Product Lines & Global Megatrends



DIYAN MARKET

Freescale Automotive MCU Focus

Safer & Autonomous Travel		A Greener World	Secure Connectivity	Mobility for Everyone	
Advanced Driver Assistance		Powertrain	Vehicle Connectivity	Driver Information	Broad Market
					
Radar	Vision/Fusion	Engine & Motor Control	Advanced Vehicle Networking	Instrument Cluster/ Infotainment	Body & General
Panther/S32R	Monitor/S32V	Mamba/Cobra/S32P	Bolero/Calypso/S32G	i.MX	S12/KEA/MagniV/S32K

Advanced safety MCU's with integrated high-performance analog and DSP

Multicore MCU with advanced image processing and SW enablement



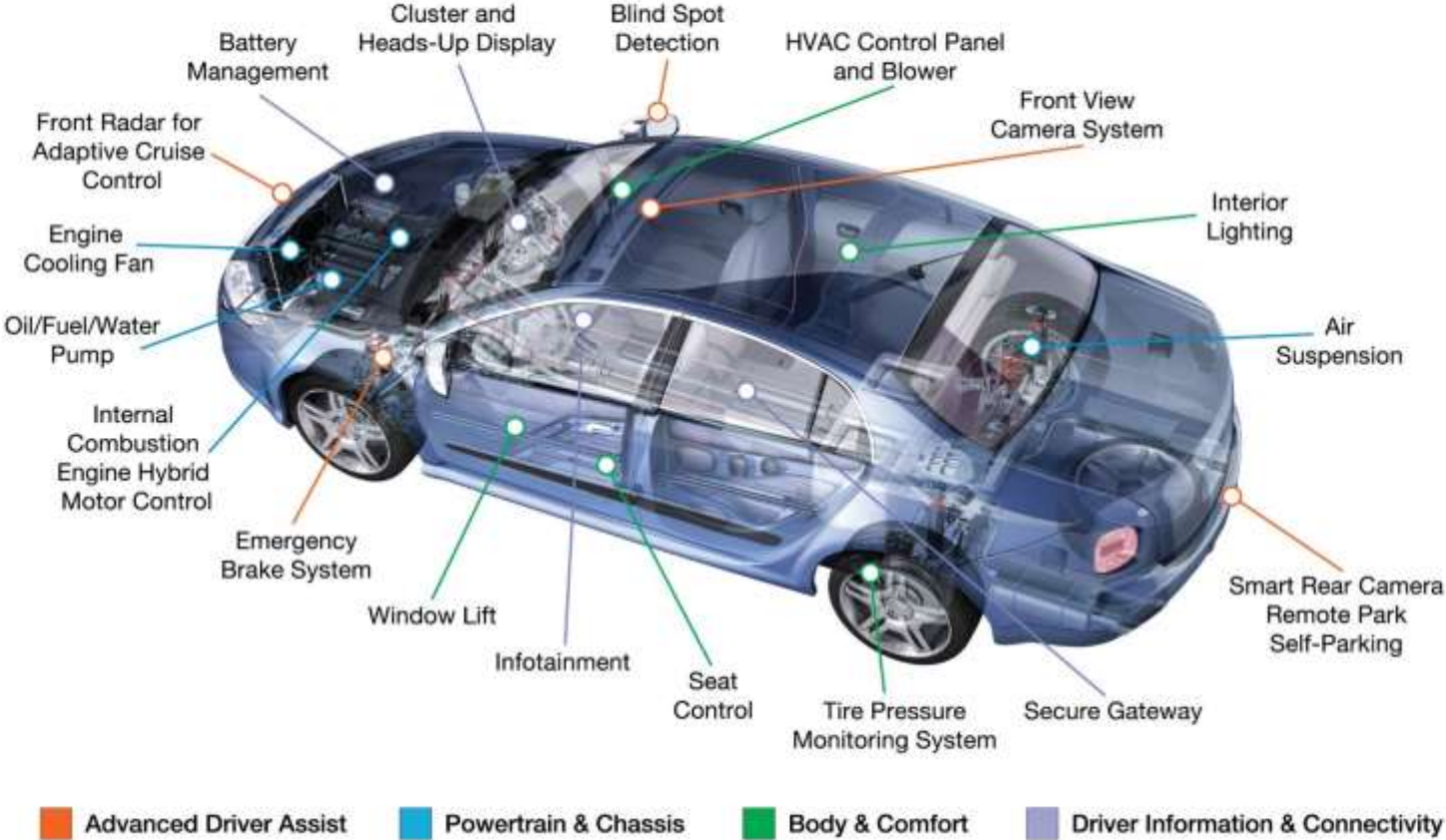
Quad-core safety MCUs with advanced timer and instrumentation systems

Advanced MCU with integrated hardware security for high-performance vehicle connectivity

Multicore MCU's with advanced multimedia features and extensive OS support

Broad General Purpose ARM Cortex Solutions and MagniV Analog and power integration for easy solution development.

Where you see Freescale...

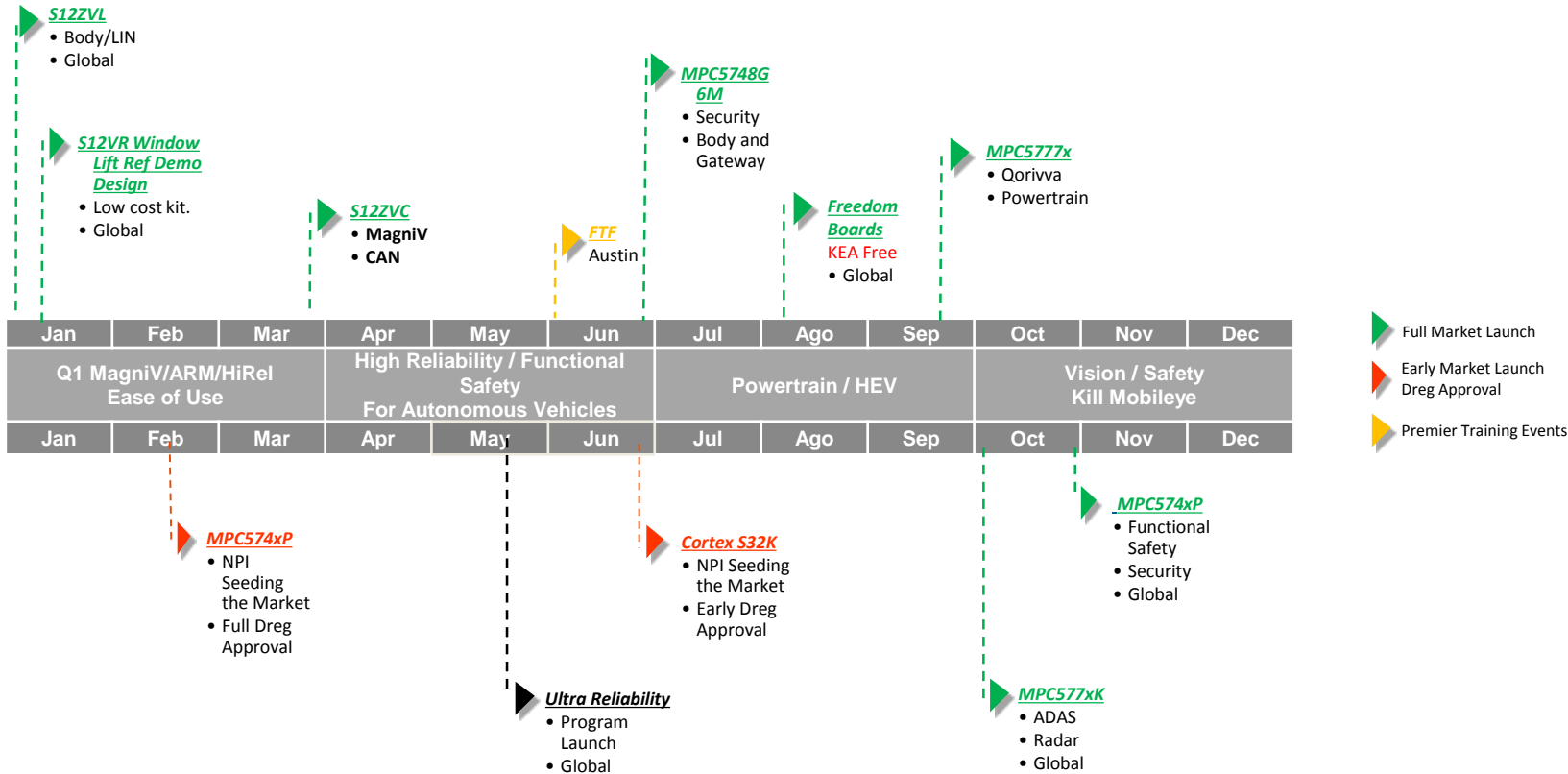


S32K100 Reuse guidelines (3)

Automotive MCUs New Product Introductions



2015 Automotive Launch & Activates



S32K100 Reuse guidelines (3)

Product Introduction - MPC57xx

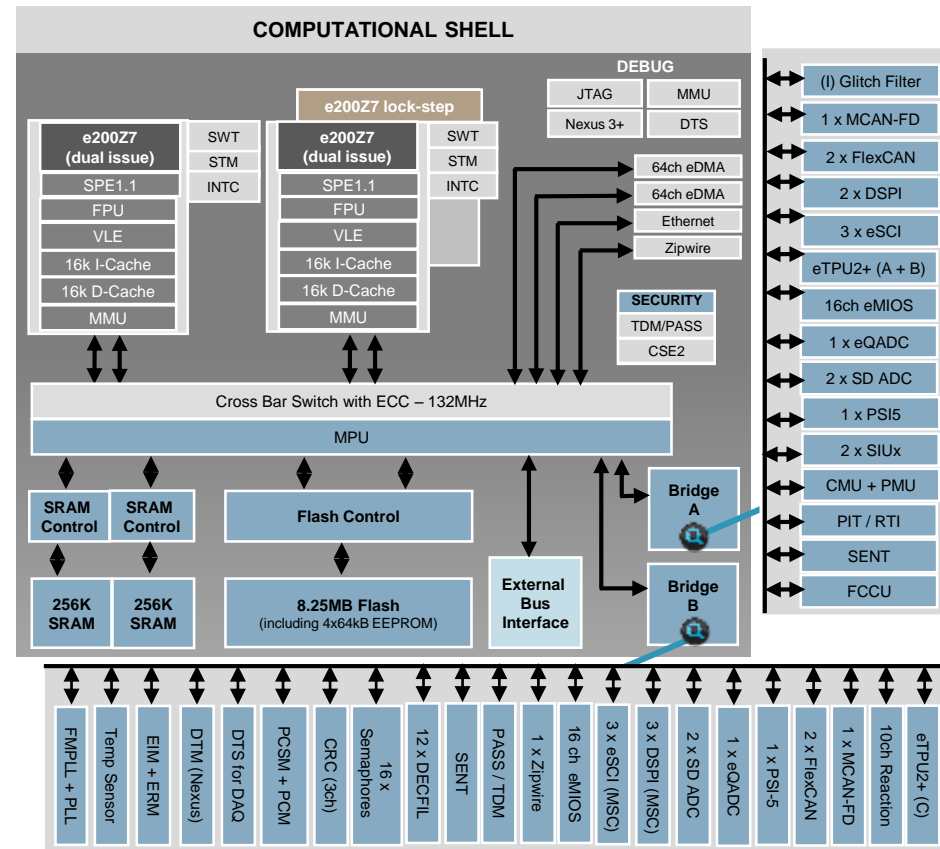
MPC5777C Block Diagram (Powertrain)

Cores & Memory

- Two independent z7 dual issue computational cores @ 264MHz
 - Cores include VLE, SPE1.1, FPU, MMU
 - 16kB i-cache & 16kB data-cache w/ coherency
- Single z7 lockstep core @ 264MHz (for ISO26262 and ASIL-D)
- Up to 8.25MB Flash RWW w/ ECC including 4 x 64kB EEPROM
- Up to 589kB total SRAM
 - 512kB on chip static RAM w/ECC (up to 48kB standby)
 - 45kB eTPU RAM, 32kB data cache (w/line locking)
- Security
 - PASS and TDM (Tamper Detection)
 - CSE2 (Crypto Services Engine for Encryption & Secure Boot)

I/O & System

- Up to 70ch eQADC from 4 converters w/12bit resolution
 - On-chip temperature sensor and VGA (x1,x2,x4)
 - 12 x Decimation Filters w/ hardware knock integrators
- 20ch $\Sigma\Delta$ ADC (4 converters w/16bit resolution)
- Timers – up to 128 channels (96ch eTPU2+ and 32ch eMIOS)
- 2 x 64ch eDMA support (128ch total)
- 6 x CAN ports (4 x FlexCAN + 2 x MCAN with Flexible Datarate)
- Ethernet
- DSPI – 5 channels (2 supporting μ Sec ch.)
- eSCI – 6 channels (2 supporting μ Sec ch.)
- Reaction module – 10 channels for current control
- Up to 12ch SENT, Zipwire, 2ch PSI-5
- 1 x CRC unit – w/ 3 independent channels,
- 4 x protected port outputs, MPU and MMU
- FMPLL + PLL
- Safety Monitors – e2eECC, CLK, Voltage, Fault Collection



MPC5777M Block Diagram (Powertrain)

Key Functional Characteristics

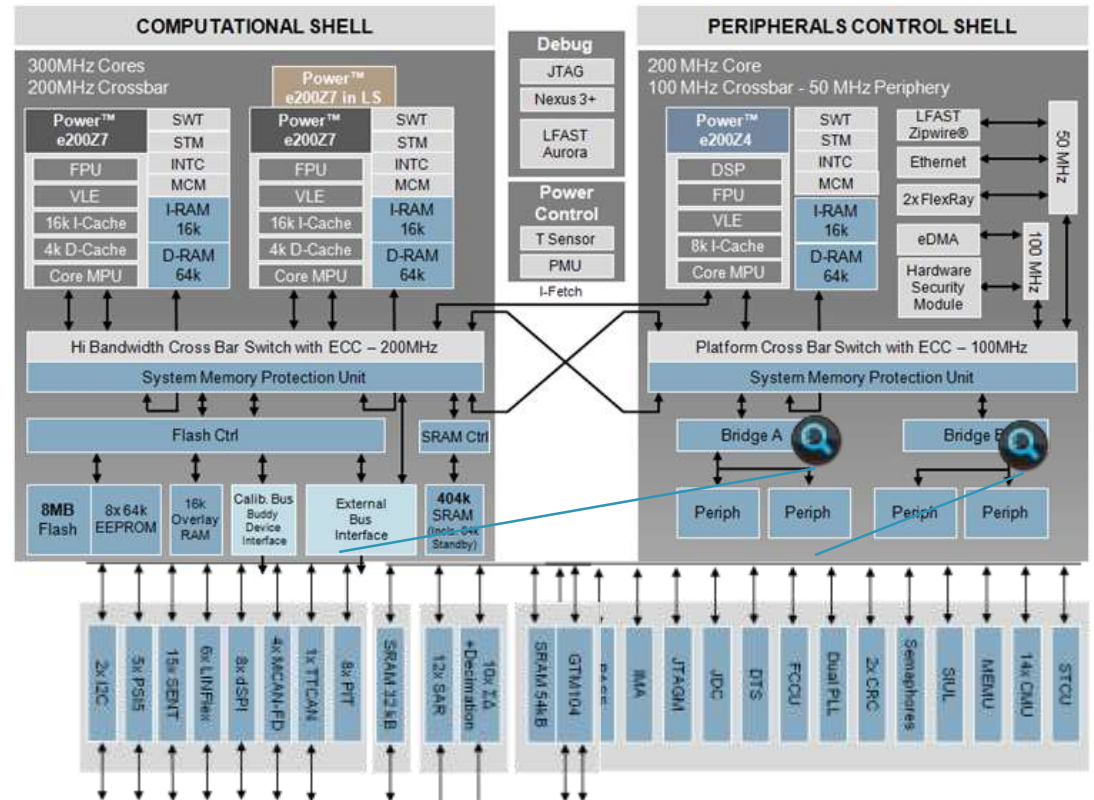
- Two independent 300 MHz Power Architecture z7 computational cores
 - Single 300 MHz Power Architecture z7 core in delayed lockstep for ASIL-D safety
- Single I/O 200 MHz Power Architecture z4 core
- eDMA controller – 128 channels
- 8M Flash with ECC
- 596k total SRAM with ECC
 - 404k of system RAM (incl. 64k standby)
 - 192k of tightly coupled data RAM
- 10 $\Sigma\Delta$ & 12 SAR converters – 84 channels
- Ethernet (MII/RMII)
- DSP/IC – 8 channels (3 supporting μ Sec ch.)
- LINFlex - 6 channels (3 supporting μ Sec ch.)
- MCAN-FD/TTCAN – 4x modules/1x module
- GTM – 248 timer channels

Key Electrical Characteristics

- -40 to +125 °C (ambient)
- 165 °C junction for KGD
- 1.26V Vdd, 5.0V I/O, 5V ADC

Package

- 292 PBGA, 416 PBGA, 512 PBGA
- eCal emulation device for each package



MPC5746R Block Diagram (Powertrain)

Key Functional Characteristics

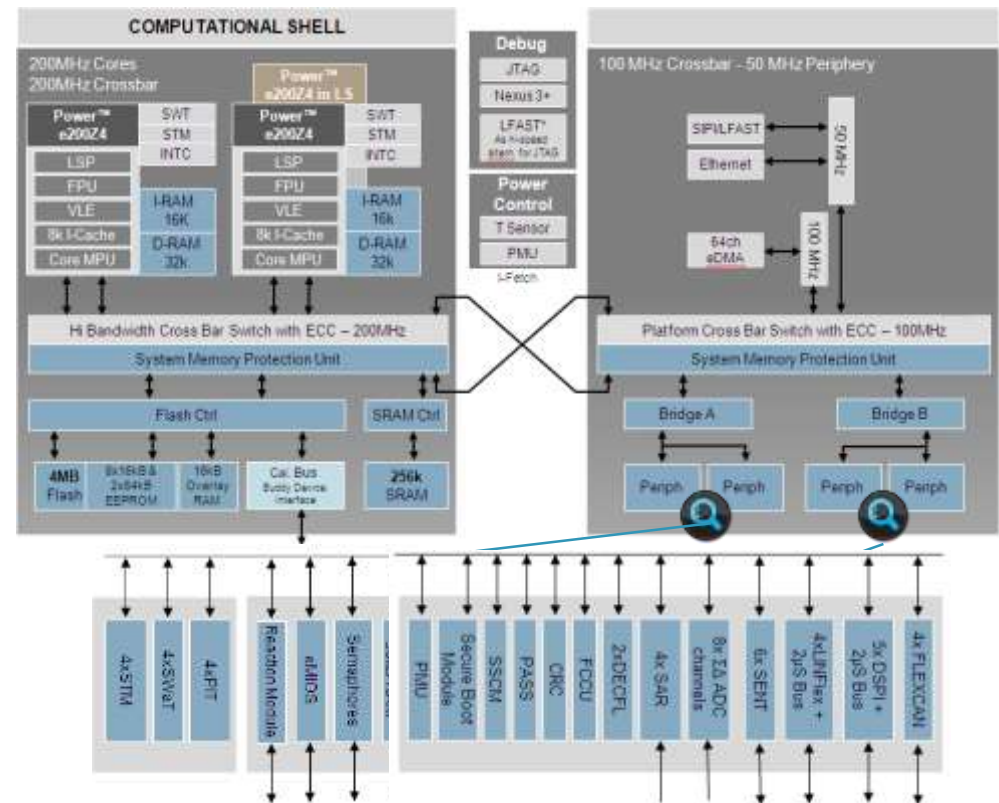
- Two independent 200 MHz Power Architecture z4 computational cores
 - Single 200 MHz Power Architecture z4 in lockstep
- 4M Flash with ECC
- 320k total SRAM with ECC
 - 256k of system RAM (incls. 32k of standby RAM)
 - 64k of tightly coupled data RAM
- 8 $\Sigma\Delta$ ADC channels, 4 SAR converters
- 50 total ADC channels
- Ethernet MII-lite
- 2 eTPU2+ timers – 64 channels
- 1 eMIOS – 32 channels
- Reaction module – 10 channels
- eDMA controller – 64 channels

Key Electrical Characteristics

- Up to 200 MHz operation
- -40 to +125 °C (ambient)
- Single 5v power supply

Package

- 176 LQFP, 252 BGA
- 292 BGA eCAL package (incls. RAM buddy chip) for emulation/debug
- *LFAST available only on eCAL package



Today's Demands Integrated Body Control/Gateway

- **Performance through Multicore**

- Up to three e200 cores built on Power Architecture technology, with up to 160 MHz performance allows for easy division of tasks in an integrated BCM/gateway system

- **Most Diverse Set of Networking Communication**

- Ethernet with AVB support, FlexRay™, MLB, USB, up to eight CAN with CAN-FD Flexible Data Rate up to 18 LIN, SDIO interface, I²S all supported on a single-chip solution

- **Flexible Memory Options**

- Up to 6 MB Flash and 768 KB of embedded SRAM provide suitable storage to maintain the local BCM/gateway application functionality, handle message buffering, and also store additional Flash images for other nodes in the vehicle

- **New Low-Power Unit**

- Allows for increased functionality in a lower power state, reducing current consumption by over 30% for a typical cyclic wake-up application over previous generation devices
- Provides a mechanism to bypass entire platform while supporting a smaller set of peripherals (1x CAN, LIN, SPI, ADC, timer, etc.) thereby providing very low power execution modes

- **Analog Comparator**

- Typical periodic monitoring routines can be fully handled in Standby mode offering a significant improvement in power consumption

- **Pretended Networking Support**

- Enabled through advanced filtering, wakeup capabilities and CAN availability in low power modes



MPC574xB/D/C/G – Family for High End Gateway/BCM Solution

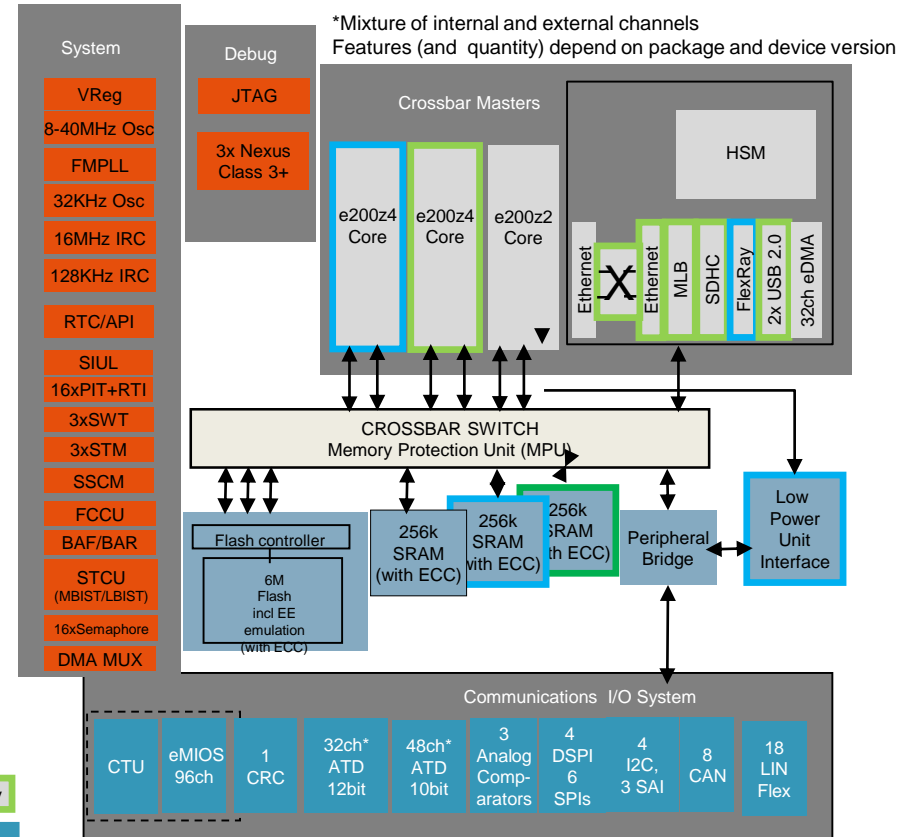
Key Characteristics:

- 2x e200z4 + 1x z2 cores, FPU on z4 cores
- 160 MHz max for z4s and 80 MHz on z2
- HSM SecuFamily rity Module option supports both SHE and EVITA low/medium standard
- Media Local Bus supports MOST communication
- 2 x USB 2.0 (1 OTG and 1 Host module) support interfacing to 3G modem and infotainment domain
- 2x Ethernet 10/100 Mbps RMII, MII, +1588, AVB
- Ethernet switch
- CAN module optionally supports CAN FD
- SDHC provides standard SDIO interface
- Low Power Unit provides reduced CAN, LIN, SPI, ADC functionality in low power mode
- Designed to ISO26262 process for use in ASIL B
- -40 to +125C (ambient)
- 3.0V to 5.5V

Packages:

- 100LQFP, 176 LQFP, 256 BGA, 324 BGA -C and -G -G only

SPC574	45/46D	45B/46B	45C-48C 46D	44G-48G
Cores	1	1	2	3
Flash	2-3M	2-3M	2-6M	3-6M
RAM	-384k	-384k	-768k	-768k
Eth/FR/ML/SD/USB	1/0/0/0/0	0/1/0/0/0	1/1/0/0/0	1/1/1/1/2 2/1/1/1/2



Calypso Family Look-up table

Flash/RAM	Package			
	100MAPBGA (11x11mm, 1mm)	176LQFP-EP (24x24mm, 0.5mm)	256MAPBGA (17x17mm, 1mm)	324MAPBGA (19x19mm, 1mm)
6M/768k		SPC5748G	SPC5748G	SPC5748G
6M/768k		SPC5748C	SPC5748C	SPC5748C
4M/512k		SPC5747G	SPC5747G	SPC5747G
4M/768k		SPC5747C	SPC5747C	SPC5747C
3M/768k		SPC5746G	SPC5746G	SPC5746G
3M/384k (512k optional)	SPC5746C	SPC5746C	SPC5746C	PPC5746C
3M/384k (512k optional)	SPC5746D	SPC5746D	SPC5746D	
3M/384k (512k optional)	SPC5746B	SPC5746B	SPC5746B	
2M/256k	SPC5745C	SPC5745C	SPC5745C	
2M/256k	SPC5745D	SPC5745D	SPC5745D	
2M/256k	SPC5745B	SPC5745B	SPC5745B	



Colour Coding:

Triple Core, Ethernet, FR, USB, SDHC,
(optional HSM, 2nd Ethernet + switch)

Dual Core, Ethernet, FR
(optional HSM, 2nd Ethernet + switch)

Single Core, Ethernet, (optional HSM)

Single Core, FR, (optional HSM)

Debug device for SPC5745B/C/D and
SPC5746B/C/D - not for production

SPC574xP Introduction

Key Technical Characteristics

- Dual Core Qorivva up to 200MHz with Local memory (64KB)
- 1M > 2.5 MB Embedded Flash with EE emulation – up to 384KB SRAM
- Delayed lock-step architecture for ASIL-D
- Developed according to ISO26262 Standard
- Option for Extended temperature up to 165C Tj

Integration and Peripherals

- Maximum compatibility to MPC5643L (pin compatible in 144LQFP)
- Supporting up to 2 motors (4 SAR A/D 1Msample)
- Inter-processor high speed serial I/F (SIPI) – Up to 300Mbaud
- New Sensor I/F: SENT for Chassis
- Ethernet 10/100
- 4x multi-chip DSPI for ASIC communication

Package: LQFP with option for MAPBGA

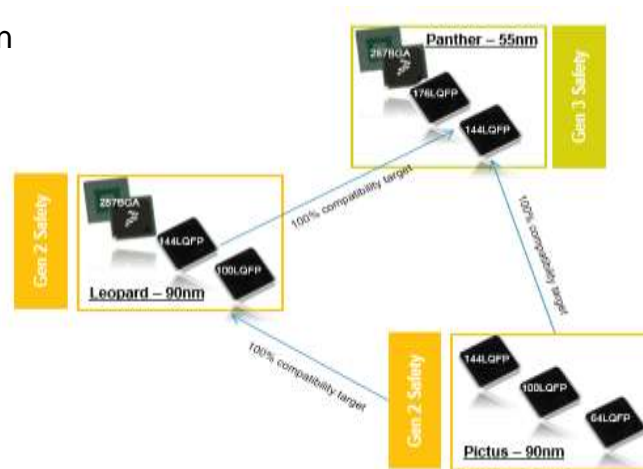
- 144LQFP, 257 MAPBGA



MPC57xx	200MHz 2.5M NVM-384k Ram
MPC57xx	180MHz 2M NVM-256K Ram
MPC57xx	160MHz 1M Flash-128kRAM

MPC57xx

- Up to 200MHz
- Dual Core – LS only
- Functional Safety –Asil D
- Up to 2.5M flash
- Up to 384k SRAM
- 144-176EP-QFP & 257BGA



Strong Intra Node scalability & Compatibility

- Pin Level
- Source/Binary level
- Package Continuum

100% pin-compatibility target between 144LQFP (Leopard to Panther and Pictus).

- Recompilation will be required (new features, new safety concept & new IPs)
- AUTOSAR availability on Leopard/Panther plus same periphery for easier migration



SPC5744P 2.5 MB

Core

- Dual up to 200 MHz Power™ ISA e200 zen4 core (Z420)
- 32 bit Reg File, 64 bit BIU with E2E ECC,
- 64kB RAM of D-LMEM with MPU for fast context switch + local data
- 8KB 2-way I-cache / 4KB 2-way D-Cache
- 1x Scalar FPU (compiler supported) per core
- Safety enhanced Cores – VLE only
- No Signal processing unit extension + NO MMU
- Delayed Lock Step configuration only

Memory

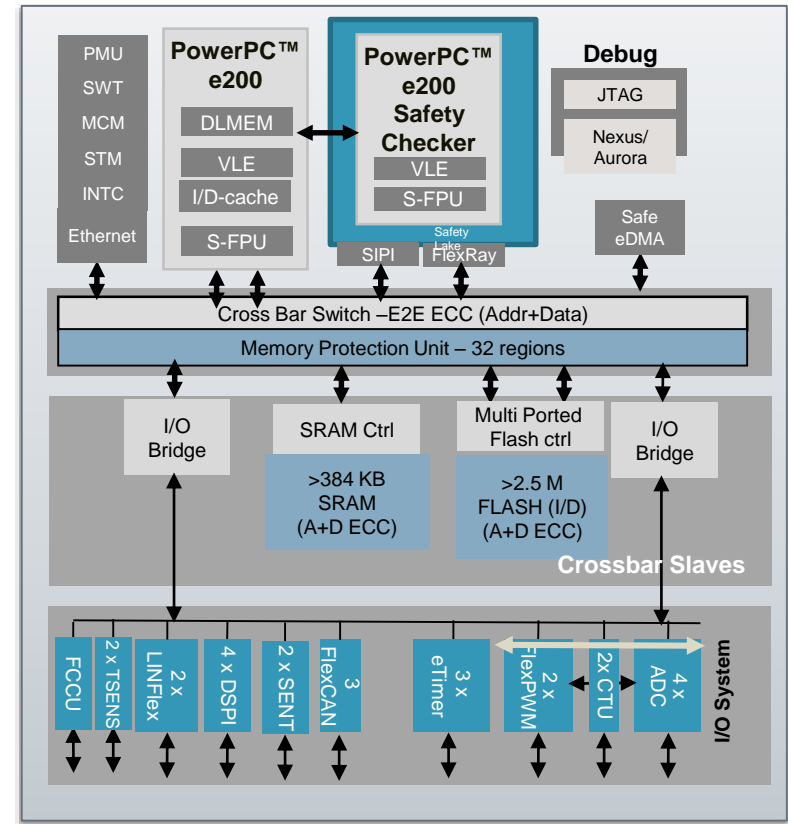
- 2.5 MBytes NVM with ECC (with add. Safety measure for address).
- 64kB EEE (Data Flash) available incl. ECC
- Up to 384 Kbyte global system SRAM with ECC (Addr + Data)

I/O

- 3 x FlexCAN (64+2x32 message buffers)
- 1 x FlexRay (Dual Channel 64 msg. buffers)
- 2 x LINFlex (Uart/Lin protocol driver)
- 4 x DSPI (4 cs each)
- 2x FlexPWM (2x 12ch for 2 independent Motors Controlled)
- 3 x eTimer modules (18 channel total)
- 4 x SAR ADC – 1MS/s target 5V input capable
- 2 x Cross-triggering unit for motor control automatism
- 2x SENT
- Ethernet (257BGA only)

System

- Interprocessor I/F SIPI (– approx 300Mbaud)
- Safe DMA
- Fault Collection unit, WDG, T-sens, & CRC computing unit
- Nexus debug interface – Aurora
- Dual-PLL (Peripheral + System Core)
- 3.3 V Single supply: internal regulator with external power stage or External supply
- 3.3 V I/Os (ADC 5 V capable)
- 144 LQFP / 257 MAPBGA 0.8 mm pitch
- Tj = 150°C . Extended Temperature at 165°C Option (separate P/N)



Automotive Software (MCAL/OS)



Software...What is the demands in Automotive?



Mars Curiosity Rover
5MLoC



Android
11.8 MLoC



F-35 Joint Strike Fighter
23.5 MLoC

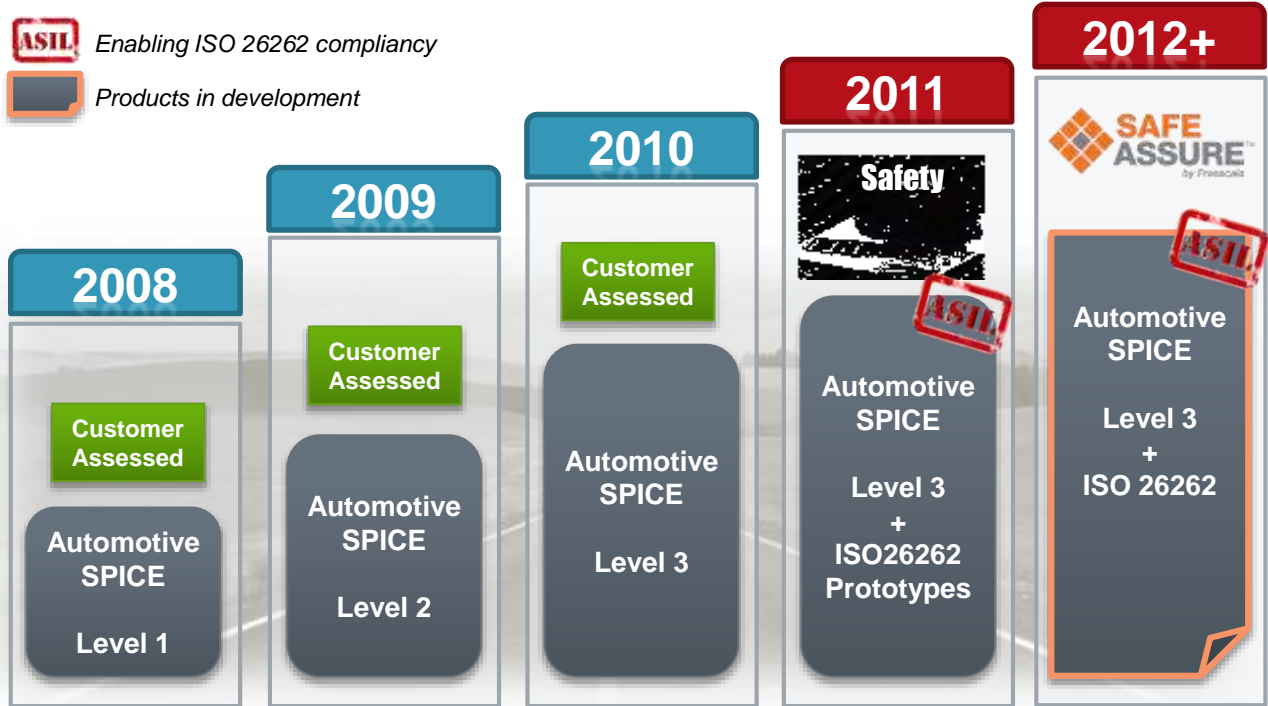


Mercedes S Class
~100MLoC

More than first perceive..?
Market leading EcoSystems...
MCAL/OS ASILD / SIL3 and beyond.

<http://spectrum.ieee.org/green-tech/advanced-cars/this-car-runs-on-code>
<http://www.informationisbeautiful.net/visualizations/million-lines-of-code/>

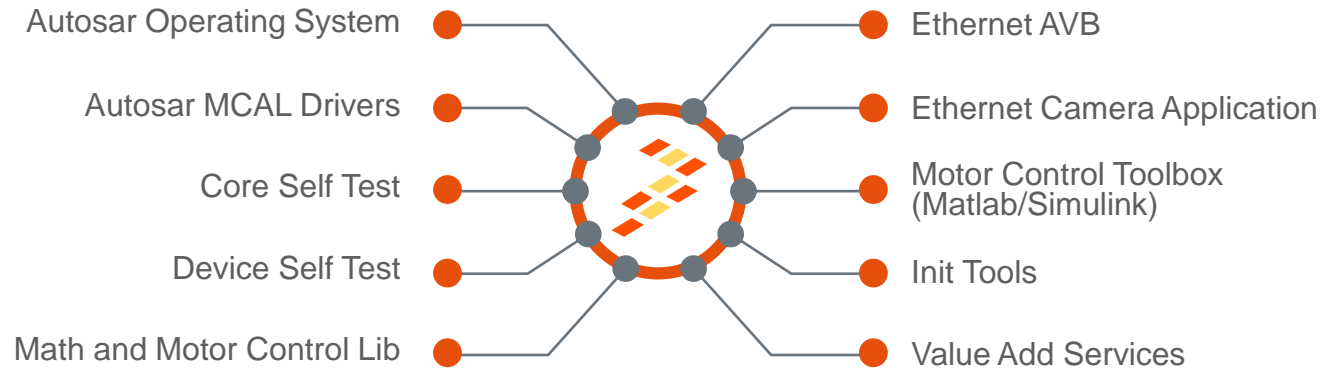
Auto SW Development Process Evolution



AUTOMOTIVE INDUSTRY REQUIREMENT

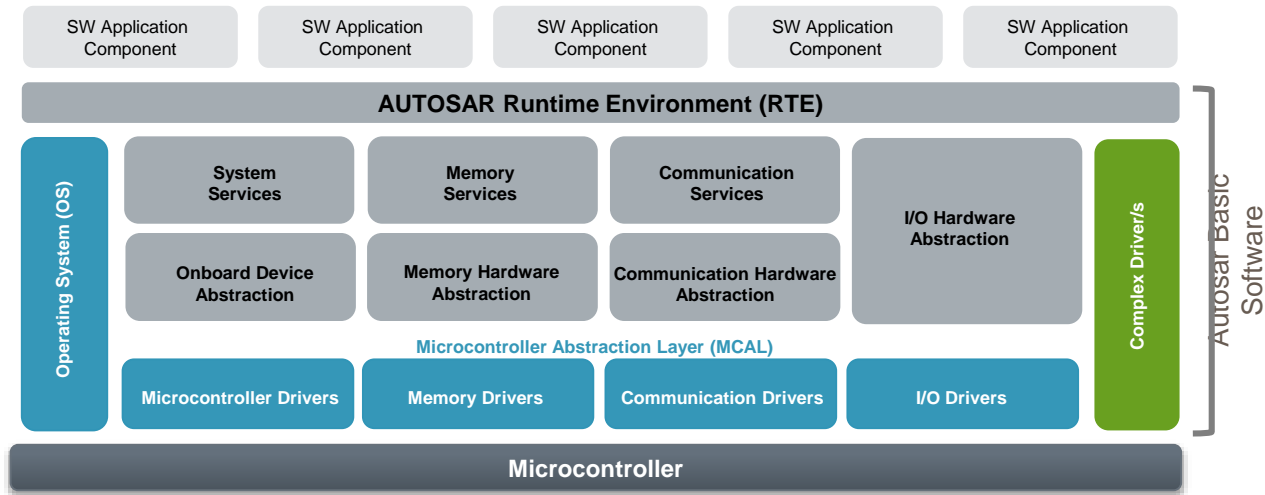
Freescale Automotive Software

Areas of Activities



Autosar Basic Software

- **Freescale Standard Products** (shaded blue below) - MCAL (source code), OS (source code) and Config Tool (executable) for MCAL and OS.
- **Partner Products** (Elektrobit, Vector, KPIT, etc.) – The rest of AUTOSAR basic software as needed & Integration Services (FSL IP + Partner IP + Customer IP)
- **Complex Drivers** (shaded green below) – custom software offered by Freescale Consulting & Professional Engineering Services



AUTOSAR Software Release Framework - Overview

Early Access Release – EAR (Lead customers only)

- Includes a subset of MCAL Drivers with limited testing coverage
- No Quality Documentation

BETA Release (all customers)

- Includes all MCAL Drivers (Feature Complete) fully verified and documented
- Includes Integration Testing
- No Quality Documentation

Release to Market Candidate – RTMC (all customers)

- Beta criteria +
- 100% Decision Coverage for one configuration
- No open S1 and S2 defects

Customer Compiler Tests (no new release)

- Specific for the provided customer compiler version and settings
- Production Approval and starting point for frozen branch support - if required by customer

		EAR	Beta	RTM-C
Content	Product scope	subset of MCAL drivers	full set of MCAL drivers	full set of MCAL drivers
	Documentation			
	Technical	subset of user documentation	full user documentation	full user documentation
	Quality docs	no	no	Complete quality package
Testing	Used HW	first samples	unqualified samples	qual-intent samples
	Test coverage	limited test coverage	all drivers fully verified, 100% of tests successfully executed	all drivers fully verified, 100% of tests successfully executed ¹⁾
	Decision coverage goal	no	90% DC for one configuration	100% DC for one configuration
	Extended testing	no	includes integration testing	includes integration testing & EPD testing
Feature coverage		partial feature coverage	100% coverage of defined features	100% coverage of defined features
Release criteria		Error Status	No open S1 defects	No open S1 & S2 defects

¹⁾ During Beta and RTMC release work, tests are added:

- To cover additional features / functionality requested after BETA release
- As test suite is continuously extended and improved over time

Freescale Automotive Software Business Model

Four Components:

Initial delivery, Support, Updates, Fixes,
Quality Reports, Development Lic. etc.

Annual Renewal

DISM Pack

Production Rights

One time Purchase

Production Licenses

Frozen Branch Releases,
Compiler Tests

Purchase as needed

Standard Services

Complex Driver / Custom Software
Development, Testing, Integration, Consulting

As needed per customer's requirements

Automotive Software
Services

AUTOSAR MCAL Availability Matrix

available
 in development / planned
 not planned

	QM				ISO26262 ASIL A-D		
ASR 4.0.3	MPC560xB/C/D			Vybrid-M4	Calypso	Panther	McKinley
	MPC564xB/C	MPC560xP	MPC564xA	Halo-M4		Racerunner	Matterhorn
		MPC564xL	MPC5676R	Rayleigh-M4			Rainier
	Calypso	MPC567xK		Treerunner-M4			Cobra55
ASR 3.0 / 3.1	<div style="border: 1px dashed black; padding: 2px; display: inline-block;"> Also ASR 3.2 MPC560xB/C/D </div>	MPC5604E	MPC563xM				
	S12X	MPC564xB/C	MPC560xP	MPC564xA			
	S12P/G		MPC564xL				
	MPC5668		MPC567xK	MPC567xF			

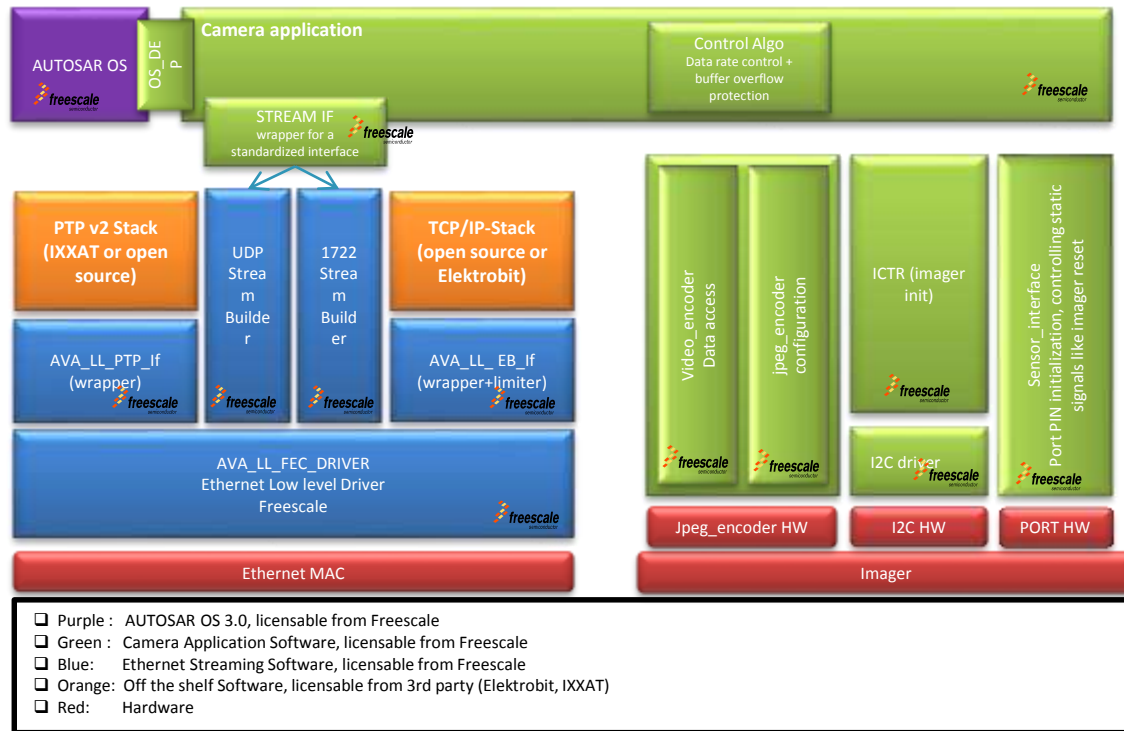
AUTOSAR OS Availability Matrix

available
 in development / planned
 not planned

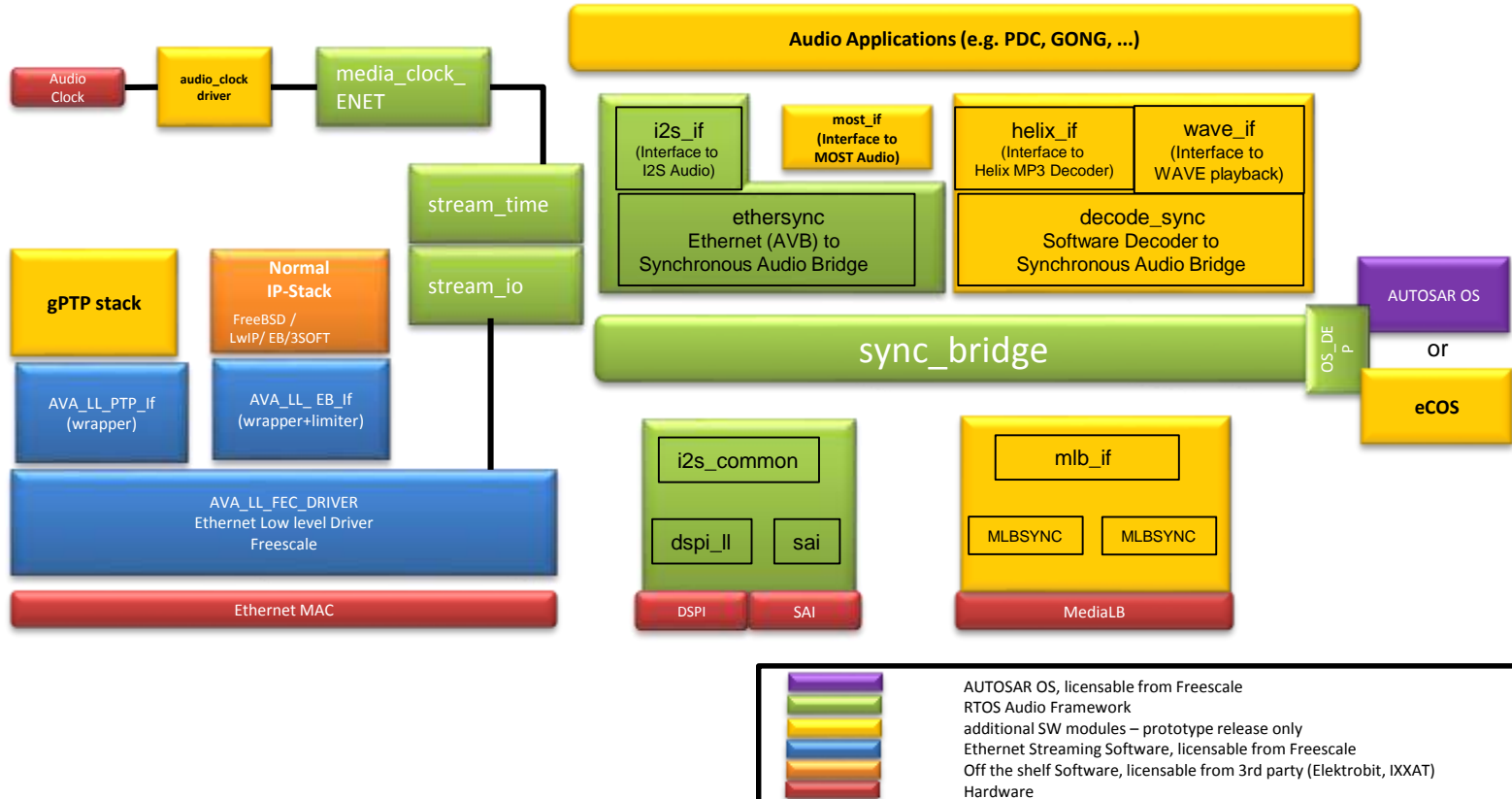
QM							
ASR 4.0.3	MPC560xB/C/D			Vybrid-M4		Panther	McKinley
	MPC564xB/C	MPC560xP	MPC564xA	Halo-M4		Racerunner	Matterhorn
		MPC564xL	MPC5676R	Rayleigh-M4			Rainier
	Calypso	MPC567xK		Treerunner-M4			Cobra55
ASR 3.0 / 3.1		MPC560xB/C/D	MPC5604E	MPC563xM			
	S12X	MPC564xB/C	MPC560xP	MPC564xA			
	S12P/G		MPC564xL				
	MPC5668		MPC567xK	MPC567xF			

Freescale Software for Surround Camera Systems

Target: Salsa



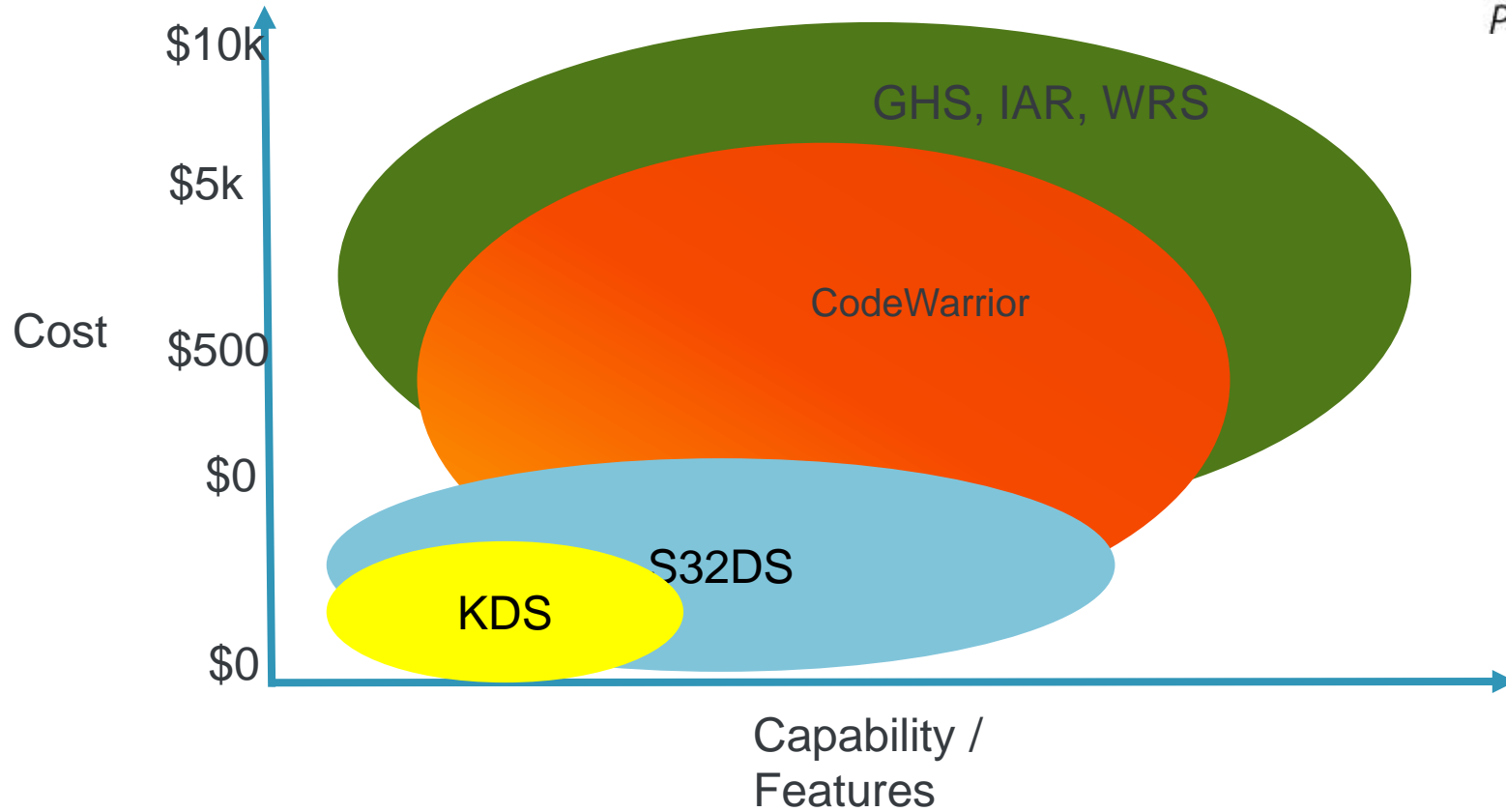
Freescale RTOS Ethernet Audio Framework



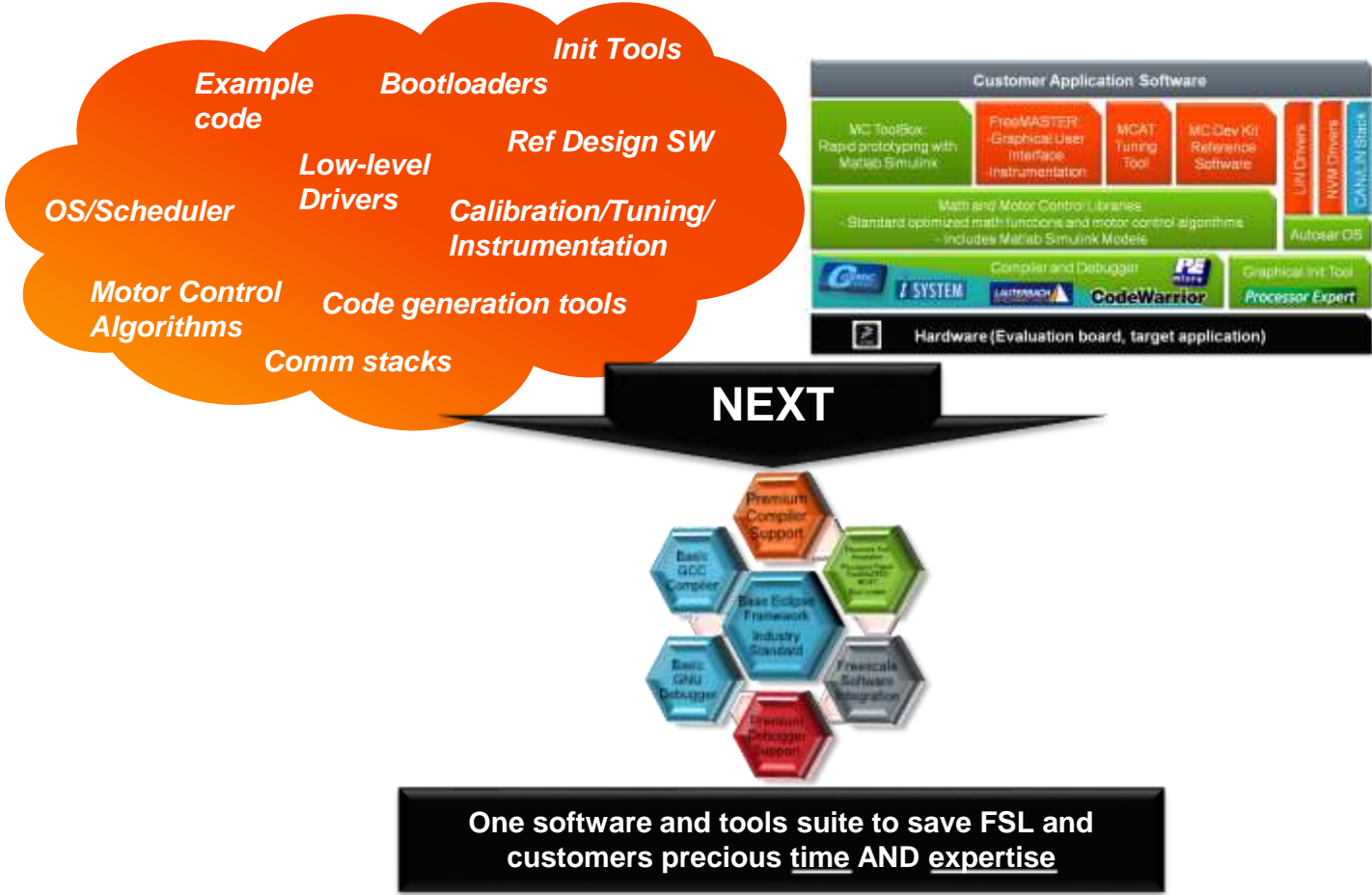
Introduction New S32DS SW Ecosystem



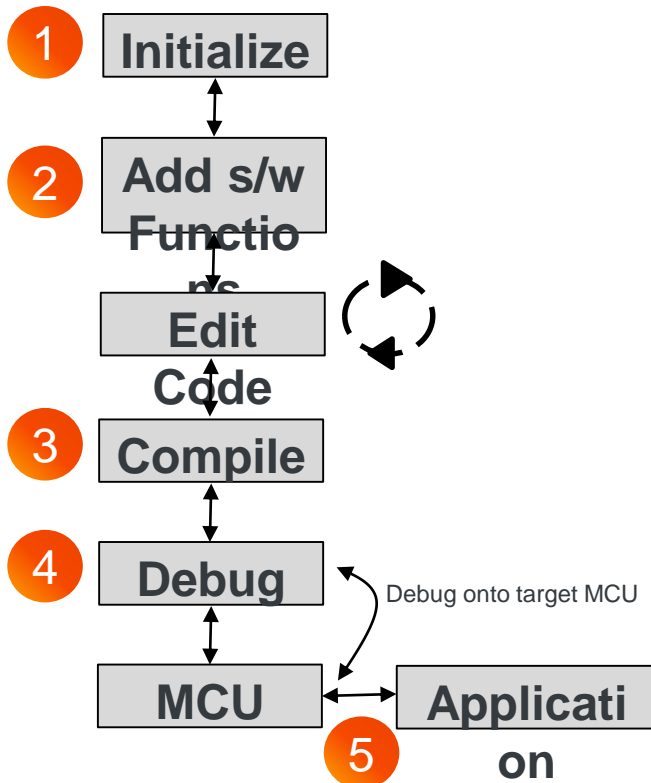
Performance Map



The Vision



S32 Design Studio: Simple 5 Step Software Development



- 1 Initialize**
 - Initialize Pin muxing (Pin Wizard)
 - Init tools (Processor Expert)
- 2 Add Plug-ins *(no separate downloads)***
 - SDK (low-level drivers)
 - MCAT (motor control tool)
 - Self-Test
 - AUTOSAR (MCAL & OS)
 - FreeMASTER
 - Bootloader
- 3 Compile**
 - GCC, GHS, IAR, Keil, CW, others...
- 4 Debug MCU**
 - GDB, Lauterbach, iSystems, others...
- 5 MCU now contains application**

S32 Design Studio: What it IS and IS NOT

IS

- More Features than KDS
- Low-cost/No-cost Software Development Tool Strategy
 - Low-Cost to develop and maintain
 - No-Cost to our customers
- GCC Base Compiler Performance
- Intended to complement and enable 3rd Party Partner Tools (Compilers & Debuggers)
- Support for Premium compilers addressing Automotive Safety Requirements
- Integration of Freescale software in easy to use environment for application development

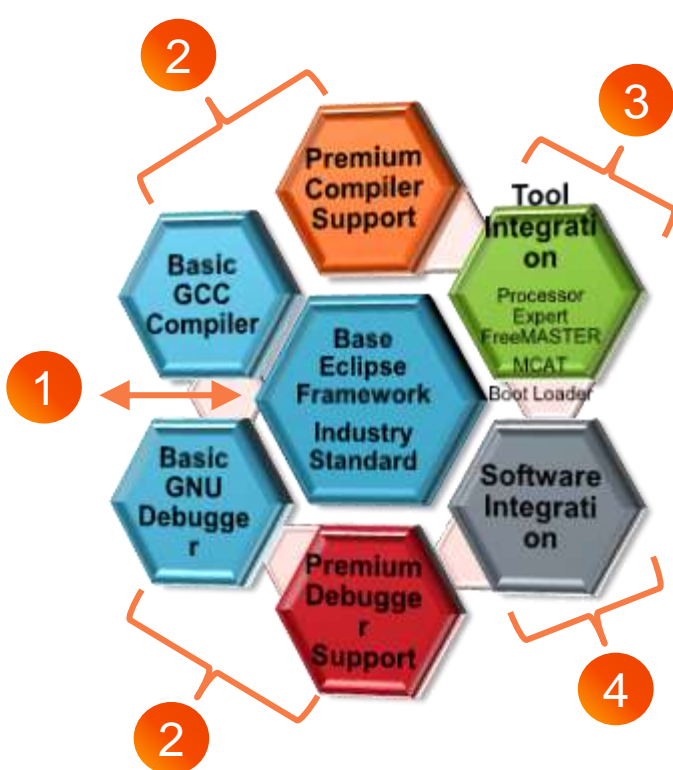


IS NOT

- KDS Equivalent
- AUTOSAR software
- CodeWarrior Replacement
- Premium Tool Replacement (w/ Advanced Debugging, Best in class code performance, etc...)

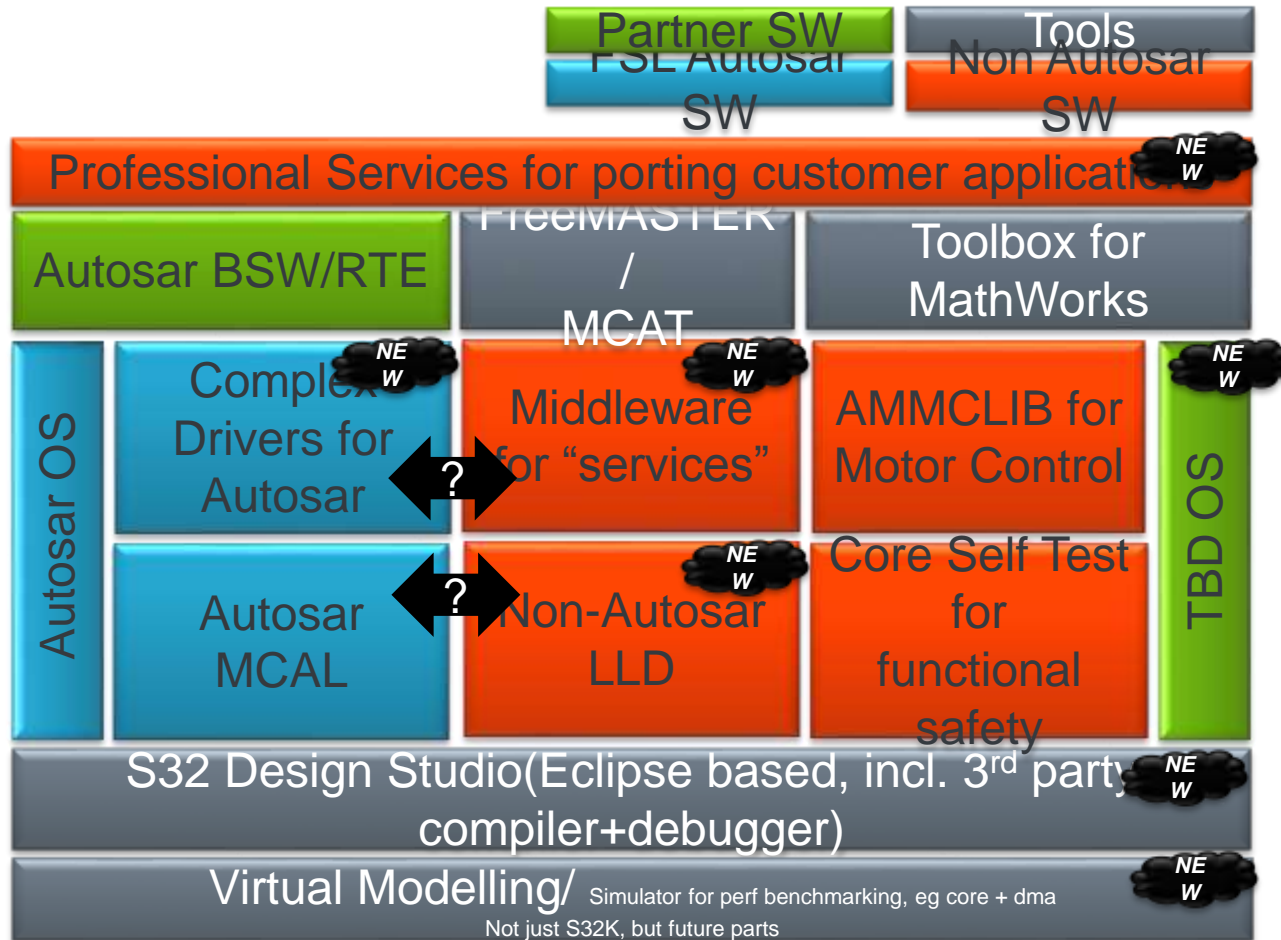


S32 Design Studio: 4 Step Software Overview



- 1 • **Create a new S32DS Project**
 - Select MCU and target package
- 2 • **Select Compiler**
 - GCC or 3rd party Premium Compiler**Select Debugger**
 - Basic GNU or 3rd party Premium Debugger
- 3 • **Select Integration tools**
 - Processor Expert
 - Bootloader
 - FreeMASTER GUI
 - Motor Control Tool (MCAT)
- 4 • **Select Software Integration**
 - Math & Motor Control Library (MMCL)
 - S32K SDK
 - Core Self-Test functions
 - Touch sensing library

Software and Tools Offering



S32DS Timing & Schedules: Power Architecture (and legacy)

	Release	2015												2016				2017				
		JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4	
Power Arch.	Beta Release					◆																
	v1.0 Release GCC 4.9 for z2 / z4 / z7 support P&E Debug							▲														
	Service Pack Update									◆	◆	◆	◆									
	v1.1 Release AMMCLib Plug-in PD1 Debugger Plug-in Support PD2 Debugger Plug-in Support PC1 Compiler Plug-in Support														▲							
	Products	2015												2016				2017				
		JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4	
S32DS for Power Arch. (and Legacy)	Matterhorn (MPC5777M)						●															
	Panther						●															
	Calypso 3M						●															
	RaceRunner						●															
	Calypso 6M						●															
	Cobra55 (MPC5777C)									●												
	Rainier (MPC5746R)										●											
	Calypso 6M											●										
	Panther Cut2.1b												●									

- ▲ Major Release/Production Release
- ◆ Product Update Ltd New Feature
- ◆ Maintenance Update Release
- ◆ Developers Release
- ◆ Beta Release



S32DS Timing & Schedules: ARM®

	Release	2015												2016				2017				
		JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4	
ARM	Beta Release Alpha SP for SW team (KFA512 v1.0)				◆																	
	v1.0 Release GCC 4.9 for M0+, M4 P&E Debug, Segger Debug						▲															
	Service Pack Update (KFA512 Final SP)							◆														
	v1.1 Release Pin Muxing KFA S32V/KFA Support Added KDS Import for KEA GCC 4.9 P&E Debug, Segger									▲												
	v1.2 Release AMMC Library PC1 Plug-in PC2 Plug-in FreeMaster PD1 Debugger Plug-in PD2 Debugger Plug-in Boot loader														▲							
Products		2015												2016				2017				
		JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4	
S32DS for ARM	KEA128				●		●		●					●								
	KEA64				●		●		●					●								
	KEA32				●		●		●					●								
	S32K1x (KFA512) *Alpha SP				●		●		●					●								
	S32K1x (KFA256)								●	●				●								
	S32V234									●				●								

-  Major Release
-  Customer driven Production Release
-  Maintenance Update Release
-  Developers Release
-  Beta Release



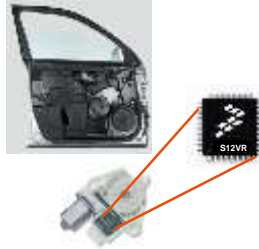
S32K100 Reuse guidelines (3)

Product Introduction - MagniV

S12 MagniV: Integration Beyond the MCU

Our **S12 MagniV** portfolio simplifies system design with the integration on High-Voltage (HV) analog features onto

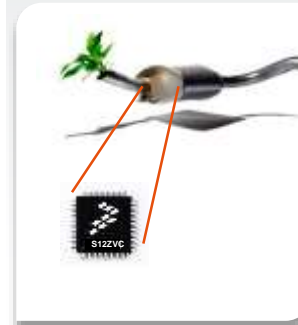
MM912/S12VR
Window Lift



S12ZVM
BLDC Motor Control



S12ZVC
Small CAN nodes



S12ZVL
LIN Nodes



- ✓ Reduced PCB Space
- ✓ Reduced Bill of Material

- ✓ Improved manufacturing efficiency
- ✓ Simplified development

S12 MagniV Benefits

S12 MagniV solutions deliver optimal **system cost** and **physical footprint** for sensor and actuator applications.



Reduced PCB Space

Up to 30%



Improved manufacturing efficiency

Replacing typically 3 IC by 1 MagniV reduces assembly and test cost while quality improves



Reduced Bill Of Material (BOM)

Fewer components to purchase, handle, store and qualify



Simplified motor control that speeds up time-to-market

Save up to 6 months on development, validation and ISO26262 implementation

- Abstract the complexity of 3-phase motor control software development
- Production ready Automotive quality SW and Tools
- SafeAssure program

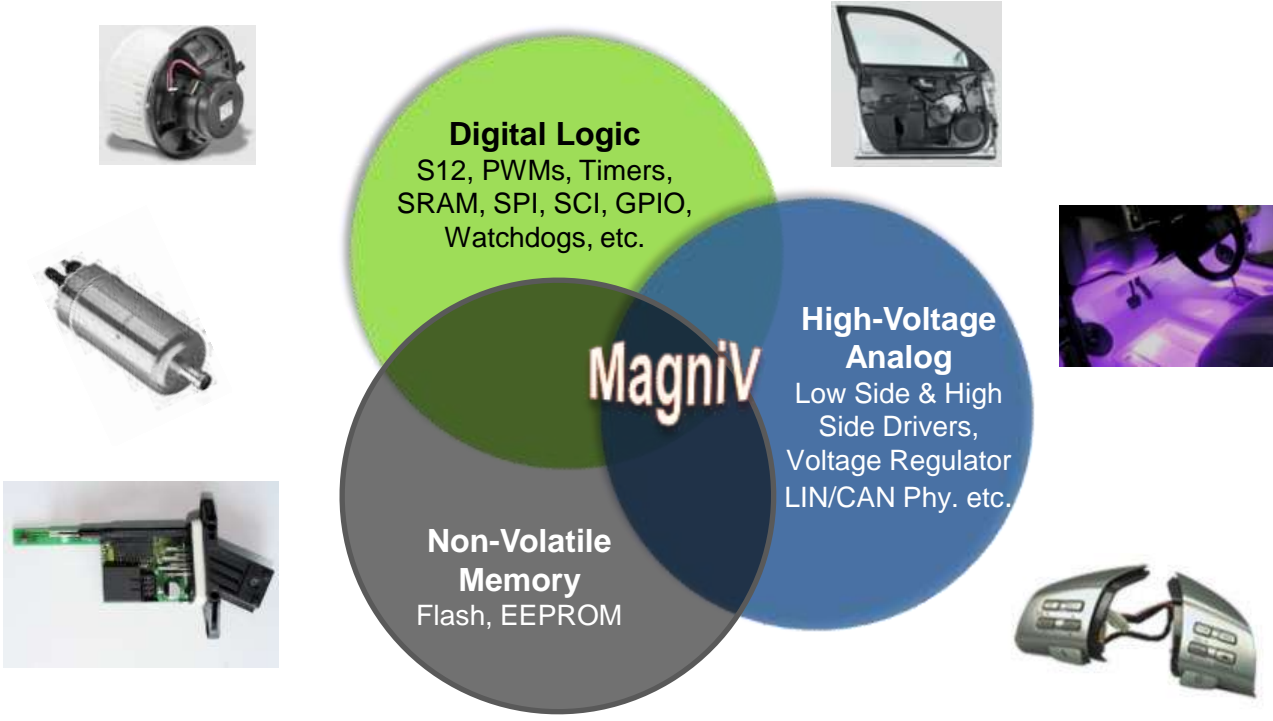


Market Trends – Sensor and Actuators

- **Reduction of power consumption**
 - LIN to reduce **cables** weight
 - **Smarter** motor control techniques
 - **Smarter** and **more** sensors
- **Reduction of physical size**
 - Electro-mechanical **integration**
 - **High temperature** >125°C Ta
- **High Growth**
 - Driven by affordability of **LIN**
 - Driven by **comfort and convenience** features



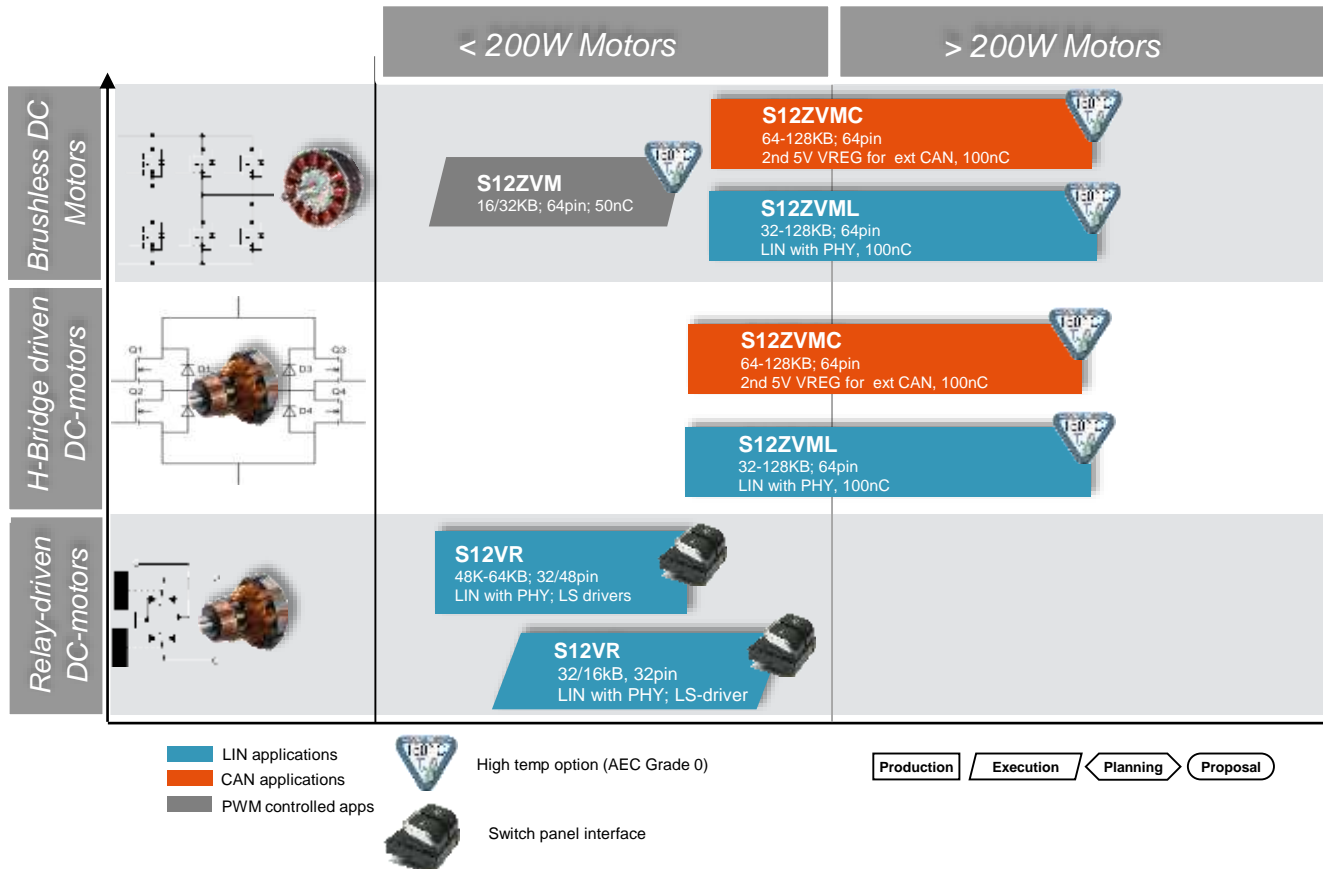
A Technology Sweetspot for Sensor and Actuators



Existing
Low Leakage 180nm CMOS+NVM

40V UHV Devices

Motor Control Solutions



SafeAssure™ Program Applied to S12 MagniV

Safety Hardware

Common safe hardware platform for application software:

- ✓ Voltage/clocks monitoring
- ✓ Memories w/ error correction
- ✓ Window Watchdog...

Safety Process

- ✓ ISO26262 development process for most products
- ✓ Safety-Element-Out-Of-Context



Safety Support

- ✓ FIT rates
- ✓ Dynamic FMEDA
- ✓ Safety manual
- ✓ Technical support as required

Safety Software




S12Z core self-test available to complement the built-in hardware safety features

Product families	Part Codenames	Development Process	FMEDA Report Availability	Dependant Failure Analysis	Safety Manual	Core Self test and User Guide
S12VR	Tomar	Standard	Upon request	Yes	No	No
S12VR	Tomarino	Standard	Upon request			
S12ZVM	Carcassonne	Standard	yes			
S12ZVM	Obidos	ISO 26262	Q4 2014			
S12ZVH	Lumen2W	Standard	Upon request			
S12ZVH	Lumen4W	Standard	Upon request			
S12ZVL	Knox	ISO 26262	yes			
S12ZVC	Hearst	ISO 26262	yes			

S12 MagniV - Product Specific Benefits

		S12VR Tomar/Tomarino	S12ZVM	S12ZVL Knox
Product specific benefits	Bill of material reduction	LIN phy VREG + Vsense 2xLS for relays 2xHS	LIN phy VREG + Vsense Gate Driver 2xOp-amps	LIN phy VREG + Vsense
	PCB Space	2-3cm ²	4-6cm ²	1-2cm ²
	Manufacturing cost	<ul style="list-style-type: none"> - Fewer components to mount (pick & place) - Less testing required for individual ICs 		
General benefits	Quality	<ul style="list-style-type: none"> - Proven high volume LL18 base technology - Fewer solder joints → fewer points of failure 		
	Logistics	<ul style="list-style-type: none"> - Fewer parts to qualify, source, store, track, etc... 		

Hardware Tools Overview

Type	Evaluation Board	Motor Control Development Kit	Mini Eval Board
			
Purpose	Evaluation and software development for either CAN or LIN target device	Spin a BLDC motors within minutes, for demo and training purposes	Low cost and small 5x9cm board for evaluation and training purposes.
HW Features	<ul style="list-style-type: none"> - LIN and CAN interfaces - Onboard BDM-to-USB - SCI-to-USB interface for Freemaster - Hall sensor interface - Resolver interface - 6 N-channel FET with 10-15A drive capability 	<ul style="list-style-type: none"> - S12ZVML12EVBLIN with pre-programmed S12ZVML128 part - BLDC motor with Hall-effect sensors mounted on plexiglas - PMSM version will also be available 	<ul style="list-style-type: none"> - S12ZVML128 part soldered - LIN connector - Onboard BDM-to-USB debug interface - 6 N-channel FET with 5-8A drive capability
Software Package	MTRCKTSBNZVM128_SW	MTRCKTSBNZVM128_SW	MTRCKTSBNZVM128_SW
Availability	Prototypes now (XS12ZVMx12EVB)	Now for BLDC e/o Q1 14 for PMSM	Orderable in March 14 First shipments mid April 14
Partnumbers	S12ZVML12EVBLIN S12ZVML12EVBCAN	MTRCKTSBNZVM128 www.freescale.com/AutoMCDevKit	S12ZVML-MINIBRD www.freescale.com/S12ZVML-MINIBRD
Price	\$349	\$789	\$69

Freescal S12ZVH Enablement

- Development Boards
 - TRK-S12ZVH128
 - TRK-S12ZVHY64
 - TRK-S12ZVFP64



- S12ZVH Reference Designs
 - (Available on request)



S12ZVH-REF-V1



S12ZVHY-REF-V1

Development Tools Ecosystem

- **Compilers**

- CodeWarrior S12Z rev. 10.3 and newer
- Cosmic

- **IDE**

- CodeWarrior 10.3
- Cosmic Zap
- eclipse

- **Programmiers**

- P&E PROGS12Z
- Cyclone Pro Programmer

- **Debugger**

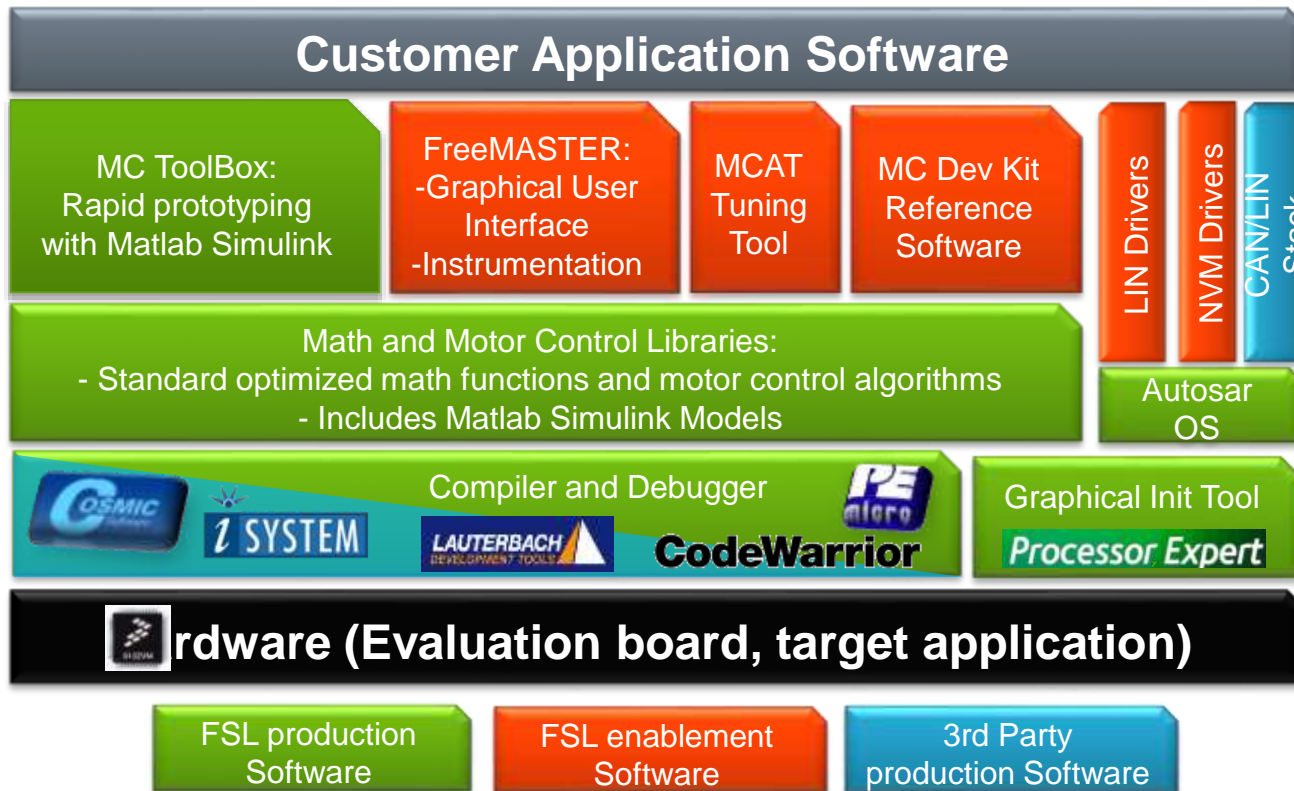
- CW & P&E S12Z Debugger
- Cosmic Zap Debugger
- iSYSTEM winIDEA

- **Support Tools:**

- Make utility – cygwin
- FreeMASTER run time debugger and for instrumentation/calibration



Ecosystem – The Complete Solution



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S32K100 Reuse guidelines (3)

Product Introduction – Kinetis EA Family

Why Cortex M0+ Series for Automotive General Purpose

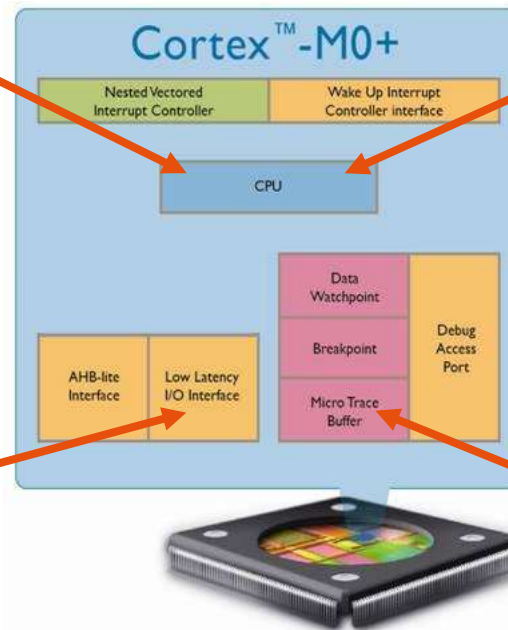
Built on the ARM® Cortex® M0+ Processor

Energy Efficiency

- 2-stage pipeline – reduced cycles per instruction (CPI) enabling faster branch instruction and ISR entry
- Program memory access on alternate cycles

Single-Cycle I/O Port

- 50% higher GPIO toggling frequency than standard I/O
- Improves reaction time to external events allowing bit-banding and software protocol emulation
- Save precious cycles, e.g. set faster peripherals for low-power access
- Access GPIO/peripherals while processor fetches the next instruction



Processing

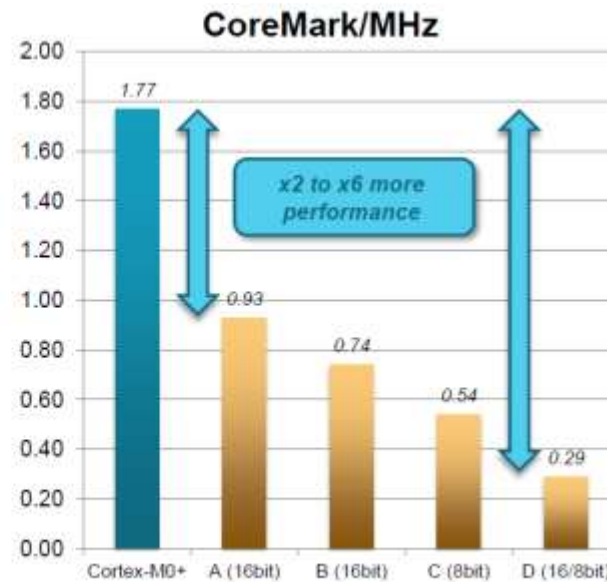
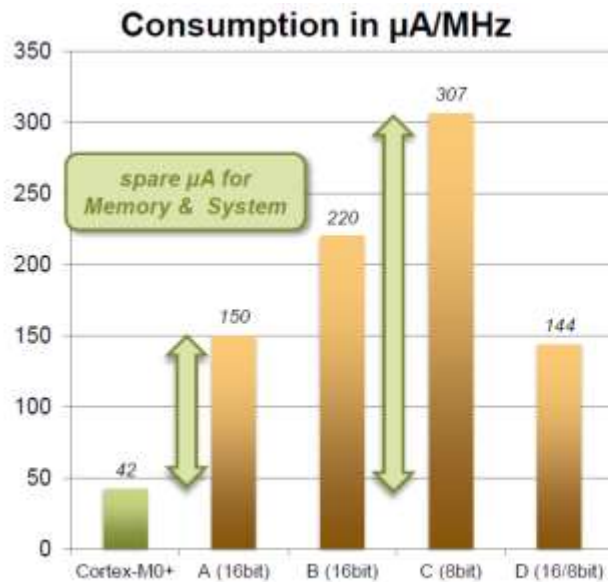
- Only 56 Instructions, mostly coded on 16-bit. Option for fast MUL 32x32 bit in 1 cycle
- Cortex-M0/3/4 compatible
- Best-in-class code density – reduced cost, power consumption and pin-count

Micro Trace Buffer

- Powerful, lightweight trace solution enabling fast debug
- Non-intrusive – trace information stored in small area of MCU SRAM (size defined by programmer)
- Trace read over Serial Wire /JTAG (CPU stopped)

Kinetis EA Benchmark

Performance & power consumption advantage



Cortex-M0+: 1.8V, 25C, std configuration, TSMC180ULL, running CoreMark

Stop mode current 1uA
M0+ 0.95 DMIPS per MHz

ARM

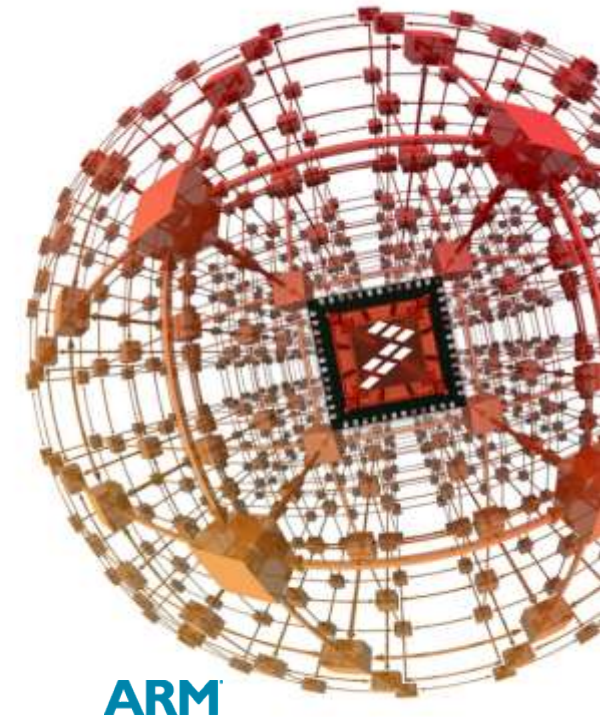
Kinetis EA Series MCUs : ARM-Based 32-bit MCUs for Challenging Environments

KEA Series MCUs: 32-bit ARM-based MCUs for Automotive

- Based on a 32-bit ARM Cortex®-M0+ 48MHz core which equals high performance with ultra-low power
- 8K to 128K embedded flash, pin-to-pin compatible
- **AEC-Q100 qualified, -40°C to 125°C**
- **Enhanced ESD/EMC (6kV HBM)**
- **Automotive connectivity: CAN, LIN (UART), SPI and I²C**
- **Automotive IPs: 12-bit ADC, ACMP, Timers (FTM, PWM, PIT, PWT, RTC)**
- $V_{DD} = 2.7 - 5.5 \text{ V}$, 3.3 V or 5 V convenience

Start Your Design Easily Today!

- **Most complete MCU + development environment**
- **24-hours to prototype, 2 months to production grade**
- Samples and Evaluation Boards (8K to 128KB)
- **Fully Qualified and Released.**



ARM



Kinetis EA128 Block Diagram

Applications:

- Automotive general purpose

Operating Characteristics:

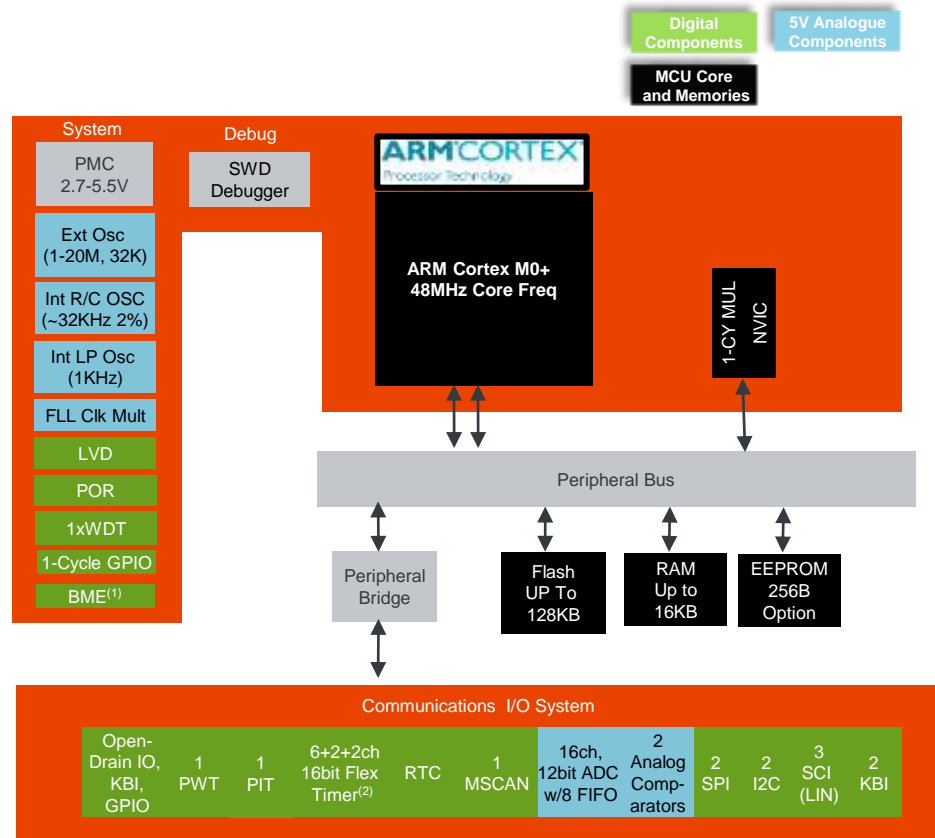
- Voltage range: 2.7 to 5.5 V
- Temperature range: -40 to 125°C

Key Features:

- ARM Cortex M0+ core 48MHz
- Up to 128K embedded flash
- Up to 16K RAM
- External OSC + internal ICS for clock
- System functions: LVD, WDG, CRC, LP modes
- Communication: SPI, SCI, IIC, CAN
- Timers: FTM, PWM, PIT, PWT, RTC
- 12bit ADC and ACMP

Packages:

- 16TSSOP, 24QFN, 32/ 64/ 80LQFP
- Pin compatible within KEA family

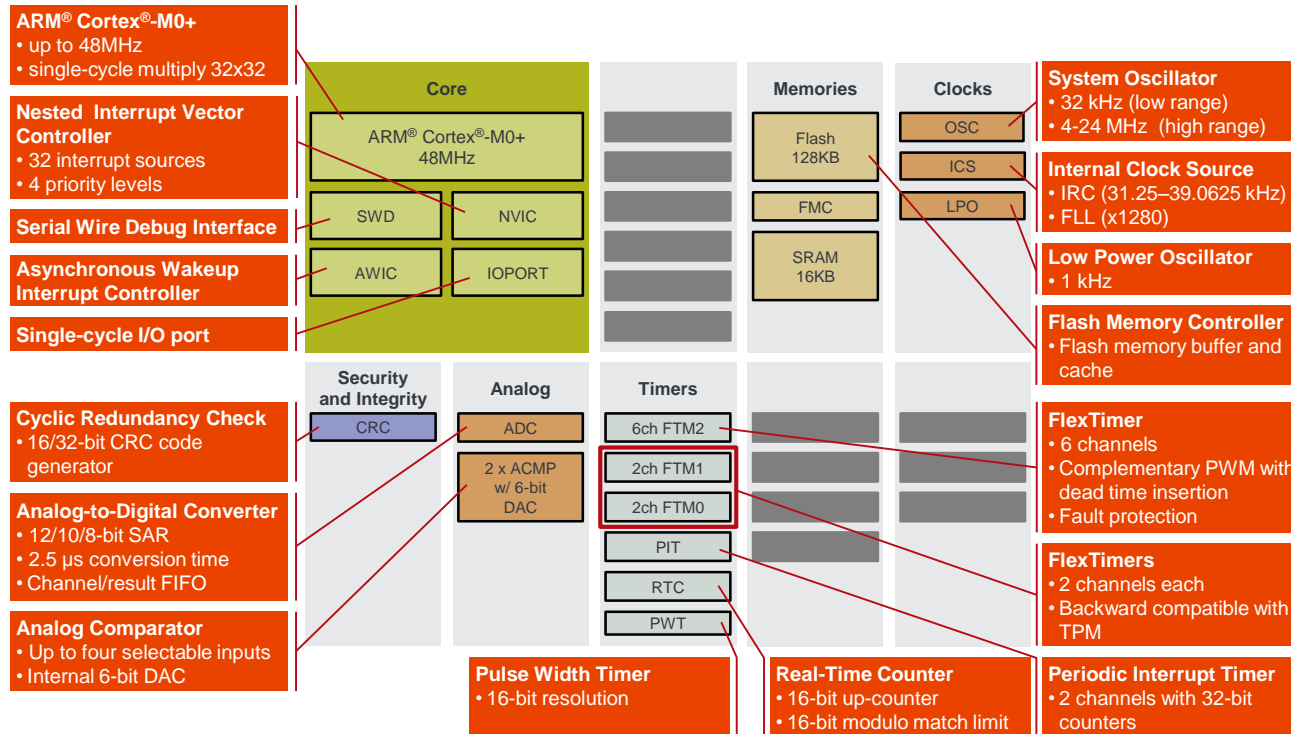


(1) Support bit operation in RAM

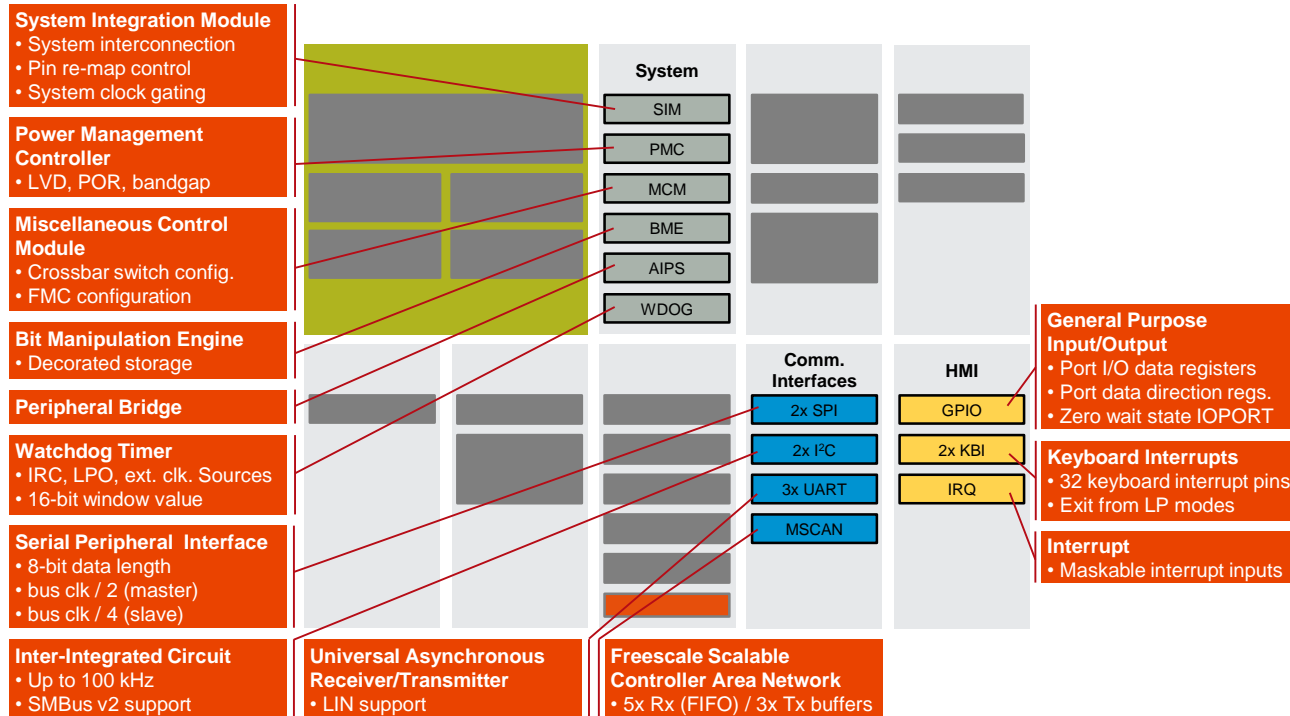
(2) Faster timer running 2 x core clock

ARM

Kinetis EA128 Block Diagrams Details



Kinetis EA128 Block Diagrams Details (Continued)



Kinetis EA Series Comparison Table

- KEA has at least the same overall quality level as existing 0.25um 16-bit Auto MCU and 0.18um 8-bit Auto MCU, but notably higher performance and richer enablement's.
- KEA has perfect runway to S32K M4/M0+ Core series solutions with even greater Low-Power enablement, system enhancements and wider memories options.

Features														
	Flash	RAM	EE PROM	Freq	MS CAN	SCI	SPI	ATD	PWT	Flex-Tim	ACMP	IIC	GPIO	Package s
KEAZN8	8K	1K	emulate	48MHz	0	1	1	12c12b	1	6c+2c 16b	2	1	Up to 22	16 TSSOP/ 24 QFN
KEAZN16	16K	2K	256B	40MHz	0	3	2	16c12b	NA	6c+2c+2 c 16b	2	2	Up to 57	32/64 LQFP
KEAZN32	32K	4K	256B	40MHz	0	3	2	16c12b	NA	6c+2c+2 c 16b	2	2	Up to 57	32/64 LQFP
KEAZN64	64K	4K	256B	40MHz	0	3	2	16c12b	NA	6c+2c+2 c 16b	2	2	Up to 57	32/64 LQFP
KEAZ64	64K	8K	emulate	48MHz	1	3	2	16c12b	1	6c+2c+2 c 16b	2	2	Up to 71	64/80 LQFP
KEAZ128	128K	16K	emulate	48MHz	1	3	2	16c12b	1	6c+2c+2 c 16b	2	2	Up to 71	64/80 LQFP

Kinetis EA/S32K100 Automotive Series has true Scalability

- Migration across the Cortex Series:
- Higher performance: core and peripherals
- Improved security & safety
- Save development cost and time with pin compatibility, SW and tool re-use

Flash	Pin Count							
	16	24	32	64	80	100	144	176
2M						S32K147*	S32K147	S32K147
1M					S32K146*	S32K146	S32K146	S32K146*
512K				S32K144	S32K144*	S32K144	S32K144*	
256K				S32K142	S32K142*	S32K142		
128K			KEAZ128*	KEAZ128/ S32K141	KEA128/ S32K141*	S32K141		
64K			KEAZN64	KEAZ(N)64	KEAZ64			
32K			KEAZN32	KEAZN32				
16K			KEAZN16	KEAZN16				
8K	KEAZN8	KEAZN8						

Kinetis EA MCUs Easy Enablement:

Rapid Prototyping for Quality Software Development

Freescale Library and Tool:

- Automotive Math and Motor Control Library for Cortex M0+
- Motor Control Application Tuning (MCAT) tool
- FreeMASTER

IDE Debugger/Compiler

- CodeWarrior 10.6, Processor Expert integrated
- S32-DS IDE
- IAR
- Keil
- Cosmic IDE for Kinetis ARM MCUs

Operating Systems:

- MQX Lite

Drivers

- Split Gate Flash Driver Software for Kinetis EA Series MCU
- Flash driver for EEPROM emulation
- LIN driver
- CAN driver
- Other peripherals and IO drivers
- Optional Autosar MCAL and Vector Driver

Debugger Interface

- P&E Micro: Umultilink

Kinetis EA MCU Low Cost StarterTRAK Boards

TRK-KEA8

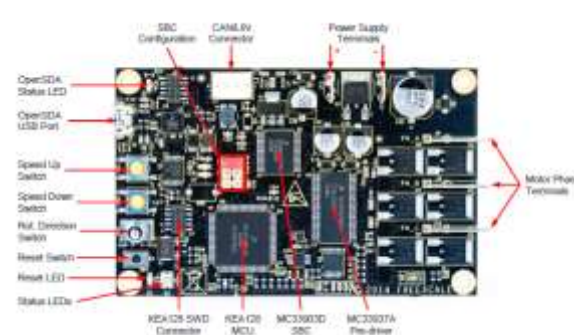
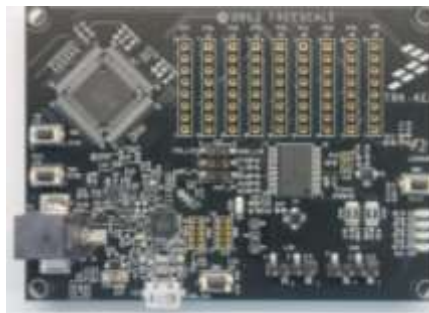
- KEA8 MCU in a 24 QFN package
- On-board openSDA debugging and programming circuit using K20 MCU
- LIN communications interface
- Analog interface with potentiometer
- High efficiency LEDs
- SCI serial communication interface

TRK-KEA64

- KEA64 MCU in a 64 LQFP package
- On-board openSDA debugging and programming circuit using the K20 MCU
- LIN communications interface
- Analog interface with potentiometer
- High efficiency LEDs
- SCI serial communication interface

TRK-KEA128

- KEA128 MCU in a 80 LQFP package
- On-board openSDA debugging and programming circuit using K20 MCU
- LIN communications interface
- Analog interface with potentiometer
- High efficiency LEDs
- SCI serial communication interface
- CAN communications interface



Motor Control Reference Design Overview



Highlights

- Based on the Kinetis KEAZ128 32-bit ARM Cortex-M0+ automotive MCU
- Motor control solution for 12 V automotive systems 3-phase sensorless brushless DC (BLDC)
- Hardware solution consists of the KEAZ128 MCU, MC33903 SBC and MC33937A 3-phase FET pre-driver
- LIN & CAN connectivity support

Integrated Software

- Automotive Math and Motor Control Library set for ARM Cortex-M0+, Application Software
- Application data visualization and control with FreeMASTER run-time debugging tool included
- Motor Control Application Tuning (MCAT) tool allows run-time tuning of the application parameters included



Kinetis EA MCUs Key differentiators...

- **Complete enablement to save development cost & time**

- Massive options of development tools, SW and HW references
- Complete ARM ecosystem

- **Super scalable product family**

- 8K to 2M embedded flash, pin to pin compatible
- Save HW&SW porting effort

- **Automotive grade Quality**

- AEC Q100 certificated, Proven automotive IP on board, Enhanced EMC/ESD performance

- **High Performance**

- 32-bit ARM[®] M0+ core, compared with 8/16bit core in similar flash size devices

- **Low power consumption**

- M0+ core optimized for low power
- Chip level low power design

- **Advanced automotive connectivity**

- Plenty of automotive peripherals including CAN, LIN(SCI), SPI, IIC etc

- **Wide operating range**

- Vdd = 2.7 - 5.5V, 3.3V or 5V convenience
- Ta = -40C to 125C

- **Ideal for vast number of automotive applications**



Kinetis EA MCUs Key differentiators...

KEA MCU is cost-effective auto-grade scalable 32-bit product family with complete ARM ecosystem for a wide range of automotive applications
Customers can start design easily today for fast prototyping!

Complete enablement to save development cost & time

- Massive options of development tools, SW and HW references
- Complete ARM ecosystem

Super scalable product family

- 8K to 2M embedded flash, pin to pin compatible
- Save HW & SW porting effort

Automotive grade Quality

- AEC Q100 certificated, Proven automotive IP on board, Enhanced EMC/ESD performance

High Performance

- 32-bit ARM Cortex-M0+ core, compared with 8-/16-bit core in similar flash size devices

Low-power consumption

- Cortex-M0+ core optimized for low-power
- Chip level low-power design

Advanced automotive connectivity

- Plenty of automotive peripherals including CAN, LIN(SCI), SPI, IIC etc

Wide operating range

- Vdd = 2.7 - 5.5V, 3.3V or 5V convenience
- Ta = -40C to 125C

Ideal for vast number of automotive applications





High-performance platforms: Safety and Security

- SW friendly flexible architecture for broad market appeal
- CPU bandwidth/DMA/FPU /Low power/CAN-FD/ Ethernet/USB/ISO26262
- HW Security...



Reduce R&D effort/Time-to-Market

- Complete enablement with tools and software ecosystem
- Expand software offering into higher levels of abstraction / model-based design



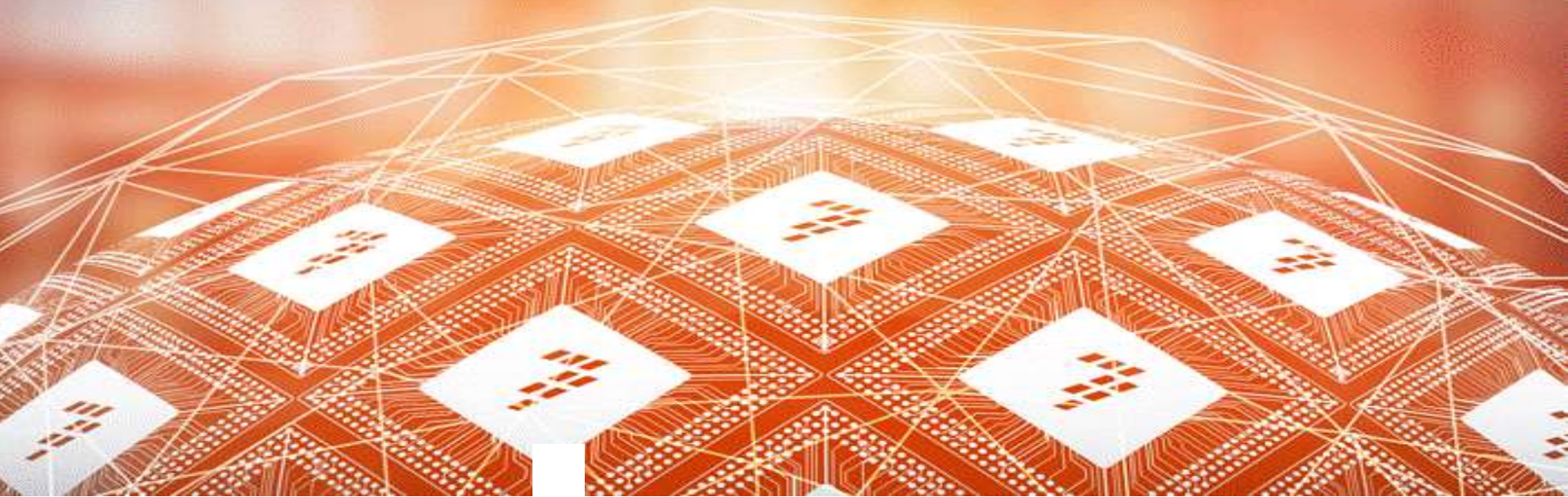
Future-proof your design

- See software as an investment, not a cost
- Scalability through portfolio





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